

Multiple Input Switch Monitor LSI for **Automotive**

BD3375MUV-M

General Description

BD3375MUV-M is a 22-channel Multiple Input Switch Monitor IC that detects the opening and closing of mechanical switches. Once it senses a change in the status of a switch, it sends an interrupt signal to the MCU via a serial peripheral interface (SPI).

The 22 switch inputs have two types of power supply, VPUB and VPUA. The VPUB and the VPUA power supplies can either be from a battery or from another power supply system. VPUB is the supply for the INB inputs while VPUA is for the INZ and INA inputs.

BD3375MUV-M has two modes of operation, Normal and Sleep. In both modes, the internal registers can be set to make the device perform either intermittent or continuous monitoring of the switches.

In intermittent monitoring, the switch status is monitored at regular time intervals, allowing the IC to operate with low power consumption. Also, operation with reduced noise can be achieved by enabling uniform sequential monitoring of all switches or sequential monitoring by power supply system.

Application

Body Control Module

Key Specifications

- Fully Functional Voltage Range: 8V to 26V -14V to +40V
- Switch Input Voltage Range:
- Selectable Wetting Current (Min):
 - 1mA, 3mA, 5mA, 10mA, 15mA

Specifications AEC-Q100 Qualified (Note 1)

- **Operational Voltage Range:** 3.9V to 8V
- Uses 3.3/5.0V SPI protocol in communicating with the MCU
- Serial communication error checking through 8bit-CRC
- Thermal Shutdown Protection (TSD)
- Power on Reset (POR)
- Selectable source/sink current levels through register settings
- Wetting current timer capability
- 8 source or sink input terminals
- 14 source input terminals
- Separable Power Supply VPUA: 16ch (INA&INZ), VPUB: 6ch (INB)
- Interrupt notification upon switch status change
- 1 to 6 times matched LPF that eliminates input terminal noise
- Low current consumption (Intermittent monitoring)
- Status display of selected terminal at DMUX terminal (Note 1) Grade 1

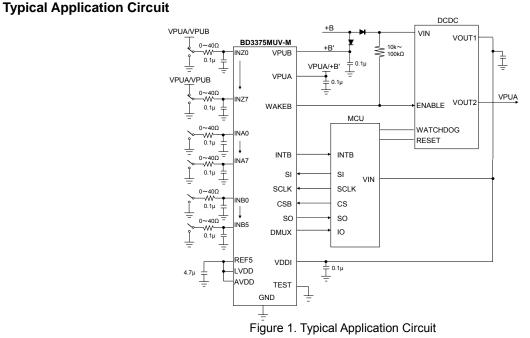
Package

VQFN48MCV070 (48 pin QFN)

W(Typ) x D(Typ) x H(Max)

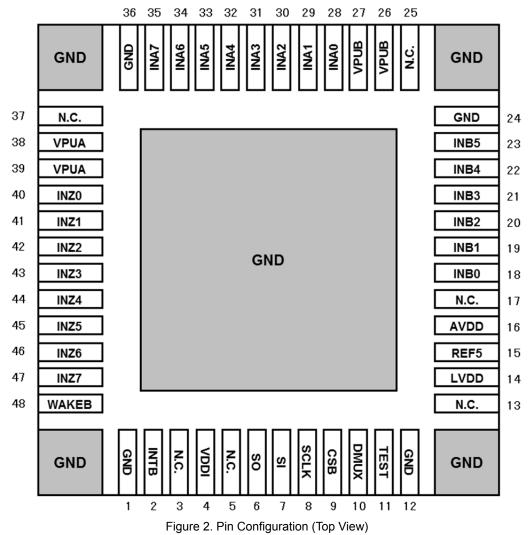
7.00mm x 7.00mm x 1.00mm





OProduct structure : Silicon monolithic integrated circuit OThis product has no designed protection against radioactive rays

Pin Configuration



Pin Description

Pin Pin No. Name Function		Eunction Description		Equivalent Circuit Diagram (Note 2)
1	GND	Ground	Ground pin	
2	INTB	Output	Open-drain interrupt output pin to the MCU (with an internal pull-up resistor)	С
3	N.C.	-	No Connection	
4	VDDI	Input	Power supply pin for CSB, SI, SCLK, SO, INTB and DMUX	
5	N.C.	-	No Connection	
6	SO	Output	SPI data output pin to the MCU	Н
7	SI	Input	SPI control data input pin from the MCU (with an internal pull-down resistor)	A
8	SCLK	Input	SPI control clock input pin from the MCU (with an internal pull-down resistor)	А
9	CSB	Input	SPI control chip select input pin from the MCU (with internal pull-up current source)	В
10	DMUX	Output	Digital multiplexer for switch input output pin	G
11	TEST	Input	Test mode control pin ^(Note 3)	J
12	GND	Ground	Ground	
13	N.C.	-	No Connection	
14	LVDD	Input	Power supply input pin for the logic block (Note 4)	
15	REF5	Output	5V power supply output pin (Note 4)	
16	AVDD	Input	Power supply input pin for the analog block (Note 4)	
17	N.C.	-	No Connection	
18	INB0	Input	Switch input pin 0 under VPUB power supply system (with an internal pull-up current source)	F
19	INB1	Input	Switch input pin 1 under VPUB power supply system (with an internal pull-up current source)	F
20	INB2	Input	Switch input pin 2 under VPUB power supply system (with an internal pull-up current source)	F
21	INB3	Input	Switch input pin 3 under VPUB power supply system (with an internal pull-up current source)	F
22	INB4	Input	Switch input pin 4 under VPUB power supply system (with an internal pull-up current source)	F
23	INB5	Input	Switch input pin 5 under VPUB power supply system (with an internal pull-up current source)	F
24	GND	Ground	Ground	

(Note 4) Short TEST pin to Ground when mounted. (Note 4) Short TEST pin to ground when mounted.

Pin No.Pin NameFunctionDescriptionCircuit Diggram Description25GND-No Connection26VPUBInputPower supply input pin for the main system and INB switches27VPUBInputPower supply input pin for the main system and INB switches28INA0InputSwitch input pin 0 under VPUA power supply systemF29INA1InputSwitch input pin 1 under VPUA power supply systemF30INA2InputSwitch input pin 2 under VPUA power supply systemF31INA3InputSwitch input pin 3 under VPUA power supply systemF32INA4InputSwitch input pin 3 under VPUA power supply systemF33INA5InputSwitch input pin 3 under VPUA power supply systemF34INA6InputSwitch input pin 5 under VPUA power supply systemF34INA6InputSwitch input pin 5 under VPUA power supply systemF35INA7InputSwitch input pin 5 under VPUA power supply systemF36GNDGroundGround37N.C-No Connection38VPUAInputSwitch input pin 7 under VPUA power supply systemF39VPUAInputPower supply input pin for INA and INZ switches39VPUAInputPower supply input pin for INA and INZ switches41INZ2InputSwitch i				Table 2. Pin Description (2)	
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47 INZ7 Input Switch input pin 7 under VPUA power supply system (with an internal pull-up/down current source)	46	INZ6	Input	Switch input pin 6 under VPUA power supply system	E
48 WAKEB Output Open-drain output pin to monitor the mode of operation (Note 5) D	47	INZ7	Input	Switch input pin 7 under VPUA power supply system	E
	48	WAKEB	Output	Open-drain output pin to monitor the mode of operation (Note 5)	D

(Note 5) In the application circuit, WAKEB should be pulled-up by an external resistor.

Block Diagram VPUA VPUA VPUA VPUB AVDD AVDD 1/3/5/10/15mA(Min) Internal Oscillator VREF5 Supply AVDD INZ0 AVDD INZ7 REF5 , To Logic 3/4V LVDD Comparator AVDD 1/3/5/10/15mA(Min) Thermal Power On Shut Down Reset x8 VDDI LVDD VDDI Logic Block VPUA DMUX VPUA AVDD 1/3/5/10/15mA(Min) DMUX Control WAKEB AVDD INA0 AVDD **I**≁¬ WAKEB Control INA7 M-∳-MV-I ⊡ To Logic 3/4V Comparator VDDI x8 M INTB Control INTB VPUB Input ╢ि VPUB **Digital Filter** AVDD 4 1/3/5/10/15mA(Min) <u>VDD</u>I Interval Timer AVDD (**1**)40µA INB0 AVDD INB5 Serial Interface To Logic CSB 3/4V and Comparator SCLK ₹ Registers SI x6 \$ Ş VDDI SO TEST GND



Absolute Maximum Ratings

Table 3	. Pin Desc	cription	1
Parameter		Ratings	Unit
Supply Voltage Range on Pin VDDI, AVDD, LVDD Input Voltage Range on Pin CSB, SI, SCLK, TEST Output Voltage Range at Pin SO, INTB, DMUX, REF5	-	-0.3 to +7.0	V
Supply Voltage Range on Pin VPUA, VPUB Voltage Range on Pin WAKEB	-	-0.3 to +40	V
Input Current at Pin WAKEB	-	10	mA
Input Voltage on Switch Pin (INB0-INB5, INA0-INA7,INZ0-INZ7)	-	-14 to +40	V
Operating Temperature Range	T _{OPR}	-40 to +125	°C
Storage Temperature Range	T _{STR}	-55 to +150	°C
Maximum Junction Temperature	Tj	-40 to +150	°C

Caution: Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins and the internal circuitry. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.

Thermal Resistance (Note 6)

Table 4. Thermal Resistance

Deremeter	Symbol Thermal Resistance (Typ)		istance (Typ)	Linit
Parameter	Symbol	1s (Note 8)	2s2p (Note 9)	Unit
VQFN48MCV070				
Junction to Ambient	θ _{JA}	83.3	24.5	°C/W
Junction to Top Characterization Parameter (Note 7)	Ψ_{JT}	8	5	°C/W

(Note 6) Based on JESD51-2A(Still-Air) (Note 7) The thermal characterization parameter to report the difference between junction temperature and the temperature at the top center of the outside surface of the component package.

(Note 8) Using a PCB board based on JESD51-3 (Table 5). (Note 9) Using a PCB board based on JESD51-5, 7 (Table 6).

Table 5, 1s

Layer Number of Measurement Board	Material	Board Size
Single	FR-4	114.3mm x 76.2mm x 1.57mmt
Тор		
Copper Pattern	Thickness	
Footprints and Traces	70µm	

Table 6. 2s2p								
Material	Board Size		Thermal V	'ia ^{(Note}	e 10)			
Material			Pitch	Di	iameter			
4 Layers FR-4 114.3mm x 76.2mm x 1.6mmt		1.20mm Ф0.3		0.30mm				
Тор		2 Internal Layers		om				
Thickness	Copper Pattern	Thickness	Copper Pattern		Thickness			
Footprints and Traces 70µm		35µm	74.2mm x 74.2mm		70µm			
	Thickness	MaterialBoard SizeFR-4114.3mm x 76.2mm x2Internal LayeThicknessCopper Pattern	MaterialBoard SizeFR-4114.3mm x 76.2mm x 1.6mmt2 Internal LayersThicknessCopper PatternThickness	Material Board Size Thermal V FR-4 114.3mm x 76.2mm x 1.6mmt 1.20mm 2 Internal Layers Botto Thickness Copper Pattern Thickness Copper Pattern	Material Board Size Thermal Via (Not Pitch FR-4 114.3mm x 76.2mm x 1.6mmt 1.20mm Φ 2 Internal Layers Bottom Thickness Copper Pattern Thickness Copper Pattern			

(Note 10) This thermal via connects with the copper pattern of all layers.

Recommended Operating Conditions

Table 7. Recommended Operating Conditions

Parameter	Symbol	Rati	Unit		
Falametei	Symbol	Min	Max		
Operating Temperature	T _{OPR}	-40	+125	°C	
VPUA/VPUB Supply Voltage	V _{VPUX}	8.0	26	V	
VDDI Supply Voltage	V _{VDDI}	3.1	5.25	V	
Capacitance for REF5 ^(Note 11)	C _{REF}	4.7	-	μF	

(Note 11) Recommend a ceramic capacitance. Please consider variation of capacitance.

Electrical Characteristics

Spec conditions: 8.0V≤VPUA/VPUB≤26V, 3.1V≤VDDI≤5.25V, -40°C≤T_{OPR}≤+125°C VPUA/VPUB/INZ/INA/INB terminal: resistors and capacitors are not connected REF5 terminal: 4.7µF

Unless otherwise specified, the typical condition is VPUA/VPUB=13V, VDDI=5.00V, T_{OPR}=25°C.

Table 8. Recommended Operating Conditions

Parameter	Symbol/Name	Min	Тур	Max	Unit
VPUA/VPUB Supply Voltage					
VPUA/VPUB Supply Voltage Low -voltage Operating Range (Note 12)	V _{VPUX(QFL)}	3.9	-	8.0	V
Fully Operational Voltage Range High-voltage Operating Range ^(Note 13)	V _{VPUX(FO)}	8.0	-	26	v
High-voltage Operating Range ^(Note 13)	V _{VPUX(QFH)}	26	-	40	
POR(Power on Reset) Activation Voltage (Note 14)	V _{POR(LOW)}	3.9	4.2	4.5	V
POR(Power on Reset) Deactivation Voltage (Note 14)	V _{POR(HIGH)}	4.0	4.3	4.6	V
VPUA/VPUB Operating Current					
Continuous Monitoring	IVPUX(OFF)	-	-	600	μA
Current source is invalid, "Hi-Z" Status					
VPUA/VPUB Average Operating Current					
Intermittent Monitoring	L		75	100	
Source/Sink Current Setting=1mA	I _{VPUX(SS)}	-	75	100	μA
Monitoring Period=50ms, Strobe Time=125µs					
VDDI Operating Current	L		5	10	
INTB="H", CSB="H"	I _{VDDI}	-	5	10	μA
REF5 Output Voltage	V _{REF5}	4.75	5.00	5.25	V

(Note 12) Electrical characteristics are not guaranteed though functions are operating. POR is active between 3.9V and 4.5V. (Note 13) Electrical characteristics are not guaranteed though functions are operating. (Note 14) The POR circuit monitors the REF5 voltage.

Table 9. Electrical Characteristics (Switch Input)							
Parameter	Symbol/Name	Min	Тур	Max	Unit		
Source Current 1 (Internal Pull-up Current Source)							
0V external supply, VPUA/VPUB system	I _{SOURCE1}	1.0	1.4	1.8	mA		
(1mA Setting)							
Sink Current 1 (Internal Pull-down Current Source)	I	1.0	1.4	1.8	mA		
8V external supply, VPUA system (1mA Setting)	I _{SINK1}	1.0	1.4	1.0	IIIA		
Source Current 2 (Internal Pull-up Current Source)							
0V external supply, VPUA/VPUB system	I _{SOURCE3}	3.0	4.2	5.4	mA		
(3mA Setting)							
Sink Current 2 (Internal Pull-down Current Source)	Lew was	3.0	4.2	5.4	mA		
8V external supply, VPUA system (3mA Setting)	I _{SINK3}	5.0	4.2	5.4	IIIA		
Source Current 3 (Internal Pull-up Current Source)							
0V external supply, VPUA/VPUB system	ISOURCE5	5.0	7.0	9.0	mA		
(5mA Setting)							
Sink Current 3 (Internal Pull-down Current Source)	I _{SINK5}	5.0	7.0	9.0	mA		
8V external supply, VPUA system (5mA Setting)	ISINK5	5.0	7.0	9.0			
Source Current 4 (Internal Pull-up Current Source)							
0V external supply, VPUA/VPUB system	I _{SOURCE10}	10.0	14.0	18.0	mA		
(10mA Setting)							
Sink Current 4 (Internal Pull-down Current Source)	lan use	10.0	14.0	18.0	mA		
8V external supply, VPUA system (10mA Setting)	I _{SINK10}	10.0	14.0	10.0	IIIA		
Source Current 5 (Internal Pull-up Current Source)							
0V external supply, VPUA/VPUB system	I _{SOURCE15}	15.0	21.0	27.0	mA		
(15mA Setting)							
Sink Current 5 (Internal Pull-down Current Source)	I _{SINK15}	15.0	21.0	27.0	mA		
8V external supply, VPUA system (15mA Setting)	ISINK15	15.0	21.0	21.0			
Low to High Switch Detection Threshold Voltage	V _{TH3(HIGH)}	2.7	3.0	3.3	V		
(3.0V Setting)	V TH3(HIGH)	2.1	5.0	5.5	v		
High to Low Switch Detection Threshold Voltage	V _{TH3(LOW)}	2.6	2.9	3.2	V		
(3.0V Setting)	V TH3(LOW)	2.0	2.3	5.2	v		
Low to High Switch Detection Threshold Voltage	V _{TH4(HIGH)}	3.7	4.0	4.3	V		
(4.0V Setting)	V TH4(HIGH)	5.7	4.0	4.5	v		
High to Low Switch Detection Threshold Voltage	V _{TH4(LOW)}	3.6	3.9	4.2	V		
(4.0V Setting)	V TH4(LOW)	0.0	0.0	7.2	v		

Table 10. Electrical C	haracteristics (Static Electr	rical Characte	eristics)		
Parameter	Symbol/Name	Min	Тур	Max	Unit
Serial Interface Threshold Voltage (Note 15)	VINLOGIC	0.8	-	2.2	V
CSB Input Current CSB=VDDI	Ісз(нідн)	-10	-	+10	μA
CSB Pull-up Current CSB=0V	I _{CS(LOW)}	30	-	85	μA
SI, SCLK Pull-down Resistor	R _{SI} , R _{SCLK}	50	100	150	kΩ
SI, SCLK Input Current SI, SCLK=0V	Isi(LOW), ISCLK(LOW)	-10	-	+10	μA
SO "H" Level Output Voltage I _{SOURCE} =200µA	V _{SC(HIGH)}	V _{VDDI} -0.8	-	V _{VDDI}	V
SO "L" Level Output Voltage I _{SINK} =1.6mA	V _{SO(LOW)}	-	-	0.4	V
SO(Set to "Hi-Z") Input Current 0V to VDDI	I _{SO(TRI)}	-10	-	+10	μA
DMUX "H" Level Output Voltage I _{SOURCE} =200µA	V _{DMUX(HIGH)}	V _{VDDI} -0.8	-	V _{VDDI}	V
DMUX "L" Level Output Voltage	V _{DMUX(LOW)}	-	-	0.4	V
INTB Internal Pull-up Current (Note 16)	I _{INTB(PU)}	15	53	85	μA
INTB "H" Level Output Voltage INTB=OPEN	V _{INTB(HIGH)}	V _{VDDI} -0.5	-	V _{VDDI}	V
INTB "L" Level Output Voltage I _{SINK} =1.0mA	V _{INTB(LOW)}	-	0.2	0.4	V
WAKEB "L" Level Output Voltage WAKEB=1.0mA	V _{WAKEB(LOW)}	-	0.2	0.4	V
WAKEB (Set to "Hi-Z") Input Current 0V to VPUB	Iwakeb(tri)	-10	-	+10	μA

(Note 15) Applicable to SCLK, SI, CSB (Note 16) VDDI= 5.0V

Parameter	Symbol/Name	Min	Тур	Max	Unit
Wetting Current Timer		13		22	ma
Counting starts after n-times detection of matched LPF	t _{wct}	15	-	22	ms
Interrupt Delay Time1					
Time from switch status change to INTB output change	t _{INTB_DLY1}	-	-	1	ms
in continuous monitoring					
Interrupt Delay Time 2				[Monitor	
Time from switch status change to INTB output change	t _{INTB DLY2}	-	_	cycle] x	ms
in intermittent monitoring	VINTB_DLT2			n+1	me
n: Setting time of LPF matched n times					
Interrupt Clear Time	t _{INTB_CLR}	-	_	150	μs
Time from CSB rising edge to INTB output change				100	μο
Command Set Time	t _{REG_EN}	-	_	150	μs
Time from CSB rising edge to setting of register	KEG_EN			100	μο
Transition Time to Normal Mode	twakeb dly1	-	_	1	ms
Time from CSB rising edge to WAKEB output change	WARED_DLTT			•	me
Transition Time to Sleep Mode	twakeb dly2	_	_	1	ms
Time from CSB rising edge to WAKEB output change	WAKEB_DLTZ			-	me
Switch Strobe Time (93.75µs Setting) (Note 17)	t _{SCAN 94}	84.375	93.75	103.125	μs
Switch Strobe Time (125µs Setting) ^(Note 17)	t _{SCAN_125}	112.5	125	137.5	μs
Switch Strobe Time (187.5µs Setting) (Note 17)	t _{SCAN 188}	168.75	187.5	206.25	μs
Switch Strobe Time (250µs Setting) ^(Note 17)	t _{SCAN 250}	225	250	275	μs
Source/Sink Current Rise Time					
FSQ="0", FSQZ/A/B="0", 10mA Setting	t _{SR_R}	-	20 ^(Note 18)	-	μs
Load Resistance 100Ω					
Source/Sink Current Fall Time					
FSQ="0", FSQZ/A/B="0", 10mA Setting	t _{SR_F}	-	15 ^(Note 18)	-	μs
Load Resistance 100Ω	_				
Internal Clock Accuracy	t _{TIMER}	-10	-	+10	%

Table 11. Electrical Characteristics (Dynamic Electrical Characteristics)

(Note 17) "H" width of internal signal (Ref. Page 12 Figure 6). (Note 18) Reference value.

Parameter	Symbol/Name	Min	Тур	Max	Unit
SCLK Frequency	f _{SCLK}	-	-	4.4	MHz
Setup Time from CSB Fall to SCLK Rise	t _{LEAD}	100	-	1000	ns
Setup Time from SCLK Fall to CSB Rise	t _{LAG}	50	-	500	ns
Setup Time from SI to SCLK Fall	t _{SI(SU)}	16	-	-	ns
Hold Time from SCLK Fall to SI	t _{SI(HOLD)}	20	-	-	ns
SI, CSB, SCLK Rise Time	t _{R(SI)}	-	5.0 ^(Note 19)	-	ns
SI, CSB, SCLK Fall Time	t _{F(SI)}	-	5.0 ^(Note 19)	-	ns
Time from CSB Fall to SO Output Low Impedance	t _{SO(EN)}	-	-	55	ns
Time from CSB Rising to SO Output High Impedance	t _{SO(DIS)}	-	-	55	ns
SCLK "H" Level Width	t _{SCLKH}	75	-	-	ns
SCLK "L" Level Width	t _{SCLKL}	75	-	-	ns
Time from SCLK Rise to Stable SO Data Output SO CL=20pF	t _{VALID}	-	25	55	ns
CSB "H" Level Time	t _{CSBH}	150	-	_	μs

Table 12 Electrical Characteristics (Digital Interface Characteristics)

(Note 19) Reference value.

Timing Chart

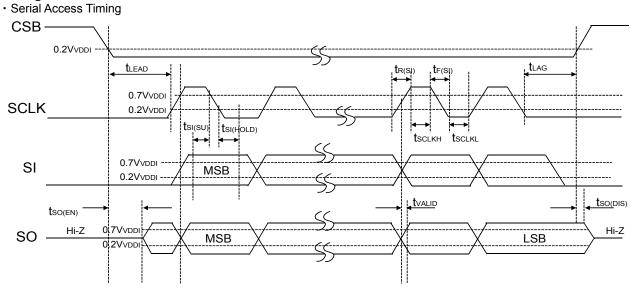


Figure 4. Serial Access Timing

BD3375MUV-M

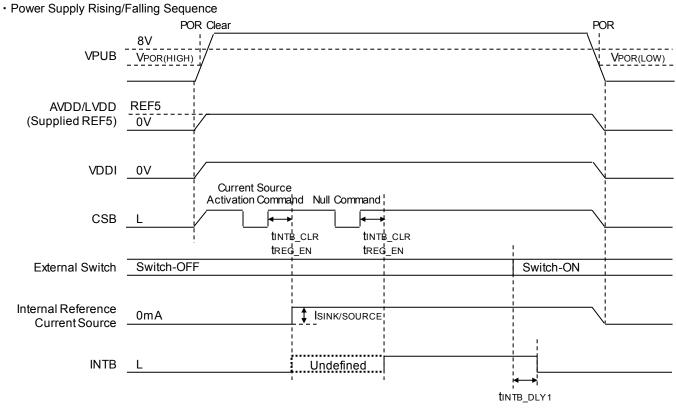


Figure 5. Power Supply Rising/Falling Sequence

Source/Sink Current Rise and Fall Time

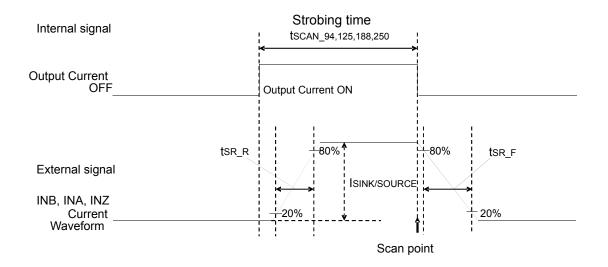
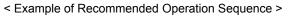


Figure 6. Intermittent Monitoring Enabled (FSQ=0, FSQZ/A/B=0, CMB/A/Z=1), Source/Sink Current Rise and Fall Time

[Basic Operation 1] Detection of Switch Status Change (Continuous Monitoring)

Upon detection of a change in switch status, interrupt (INTB="H" \rightarrow "L") occurs and the IC requests serial communication with the MCU.



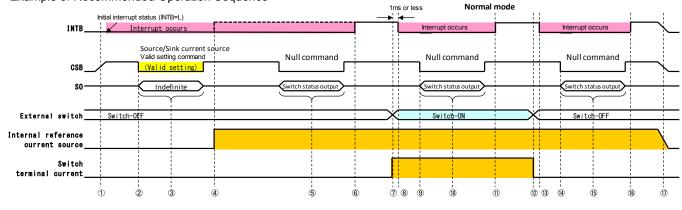


Figure 7. Basic Operation 1

①After power is turned on, interrupt (INTB="L") occurs.

②By serial communication, the switch status is obtained by the MCU at CSB falling edge.

③Since the current source is OFF, the switch terminal is "Hi-Z", and the output of SO is undefined.
 ④Internal reference current source is activated

(5) Switch status is output by SO.

(6)Interrupt is cleared (INTB="L"→ "H") by CSB rising edge and prepares for switch change. ⑦Switch change occurs (OFF→ON) and IC detects switch status change.

(a) Solution ($INTB="H" \rightarrow "L"$) is notified to MCU, and serial communication is requested (9) By serial communication, switch status is obtained by the MCU at CSB falling edge.

(1)Switch status is output by SO.

(1)Interrupt is cleared (INTB="L" \rightarrow "H") by CSB rising edge and prepares for switch change. (2)Switch change occurs (ON \rightarrow OFF) and IC detects switch status change.

 $(INTB="H" \rightarrow "L")$ is notified to MCU, and serial communication is requested

By serial communication, the switch status is obtained by the MCU at CSB falling edge.Switch status is output by SO.

(f)Interrupt is cleared (INTB="L" \rightarrow "H") by CSB rising edge and prepares for switch change. (f)Power is turned off.

[Basic Operation 2] Detection of Switch Status Change (Intermittent Monitoring)

When Intermittent Monitoring is enabled, switch status is monitored by periodically turning the current source on and off. Intermittent monitoring allows low power consumption.

< Example of Recommended Operation Sequence >

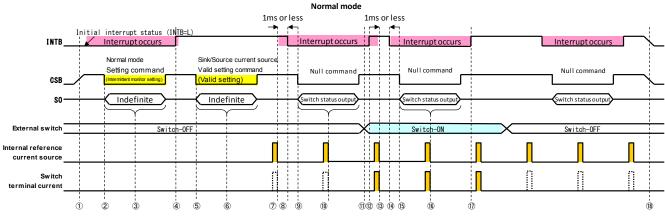


Figure 8. Basic Operation 2

①After power is turned on, interrupt (INTB="L") occurs.

②By serial communication, the switch status is obtained by the MCU at CSB falling edge.

③Since the current source is OFF, the switch terminal is "Hi-Z", and the output of SO is undefined.

(4)Interrupt is cleared (INTB="L" \rightarrow "H") by CSB rising edge and prepares for switch change.

(5)By serial communication, switch status is obtained by the MCU at CSB falling edge.

⑥Since the current source is OFF, the switch terminal is "Hi-Z", and the output of SO is undefined. ⑦IC gets the switch status when the current source is ON.

 $(INTB="H" \rightarrow "L")$ is notified to MCU, and serial communication is requested

(9)By serial communication, switch status is obtained by the MCU at CSB falling edge.

(1)Switch status is output by SO.(1)IC detects switch status change.

(1) Interrupt is cleared (INTB="L" \rightarrow "H") by CSB rising edge and prepares for switch change. (3) IC detects switch status change.

() Interrupt (INTB="H" \rightarrow "L") is notified to MCU, and serial communication is requested By serial communication, switch status is obtained by the MCU at CSB falling edge.

(6)Switch status is output by SO.

DInterrupt is cleared (INTB="L" \rightarrow "H") by CSB rising edge and prepares for switch change. BPower is turned off.

[Basic Operation 3] Sleep Mode Operation (Manual Transition)

When MDC register of Monitor Mode Transition Command is set to "1", mode is changed to sleep. When MDC register of Monitor Mode Transition Command is set to "0", mode is changed to normal. During sleep mode, WAKEB is in "Hi-Z" state and its voltage level is the level of the external pull-up.

< Example of Recommended Operation Sequence >

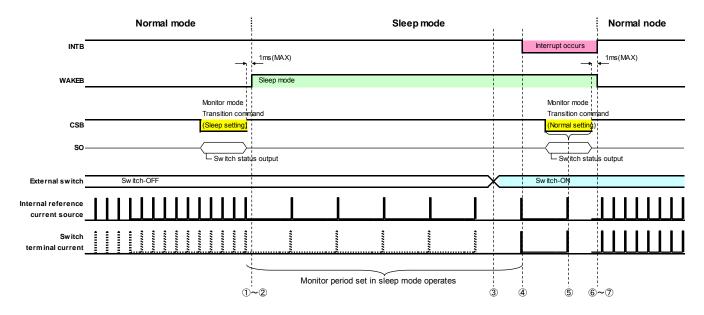


Figure 9. Basic Operation 3

①Monitor mode transition command (Sleep mode setting) is received from MCU.

②Transition to sleep mode.

③Switch change occurs (OFF \rightarrow ON).

④IC detects switch status change.

(5)IC informs MCU the interrupt (INTB="H" \rightarrow "L") and switch status is output by SO.

6 Monitor mode transition command (Normal mode setting) is received from MCU.

⑦Transition to normal mode.

[Basic Operation 4] Sleep Mode Operation (Automatic Transition to Normal Mode)

Automatic transition from sleep mode to normal mode when a switch status changes is possible when the automatic mode transition setting is enabled.

During sleep mode, WAKEB is in "Hi-Z" state and its voltage level is the level of the external pull-up.

< Example of Recommended Operation Sequence >

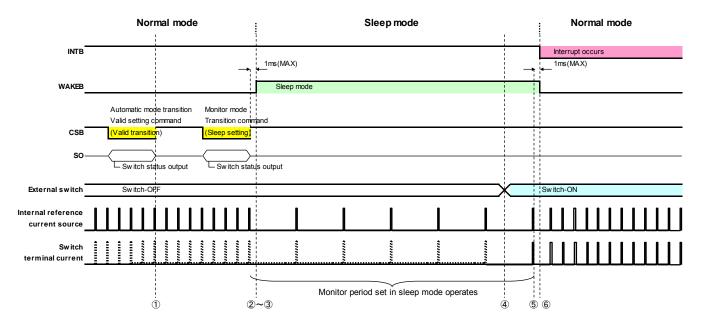


Figure 10. Basic Operation 4

①Automatic transition of mode is enable.

②Monitor mode transition command (sleep mode setting) is received from MCU.

③Transition to sleep mode.

(4)Switch change occurs (OFF \rightarrow ON).

⑤IC detects switch status change.

(6)IC informs the interruption to MCU with INTB("H" \rightarrow "L") and changes to Normal mode automatically.

Description of Functions

1. Power on Reset (POR)

Upon the application of an external voltage to VPUB, REF5 output is generated by the LDO inside the IC. When REF5 \leq 4.2(Typ), POR is activated. When REF5 \geq 4.3(Typ), POR is deactivated.

2. Serial Interface

Communication between BD3375MUV-M and the MCU uses terminals chip select bar input (CSB), serial clock input (SCLK), serial data input (SI), and serial data output (SO).

CSB is internally pulled-up to VDDI. When CSB status is "0", SCLK and SI inputs are valid, and it is possible to read data from SO. When CSB status is "1", SCLK and SI inputs are invalid, and SO status is "Hi-Z".

Communication Frame

The transmitted frame by the MCU is a 40-bit structure composed of the transmission and reception discrimination (2-bit), the address (6-bit), the data (24-bit), and the CRC (8-bit). The transmission and reception discrimination (2-bit) is intended to differentiate between the transmitted and the received frame. The command (6-bit) sets various settings such as the "valid interrupt setting command". The CRC (8-bit) outputs the result of a 39 to 8 bit CRC calculation. If a CRC error occurs, either when the structure of the frame is not 40-bit or when the transmission and reception discrimination bit is an error (the 33-bit of the SO frame is "H"), communication error is output and data is not recognized. As for writing, SI data is latched by internal shift register at timing of SCLK falling.

			Ta	able 1	3. Se	erial D)ata I	nput	(SI)								
Communication frame	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
SI input bit	Register address Setting data																
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
								Settin	g data							-	CRC

The received frame by the MCU has two types of bit alignment, "switch status output" and "register value output".

The switch status output bit alignment is a 40-bit structure composed of transmission and reception discrimination (2-bit), a fixed value (1-bit), interrupt factor output (5-bit), another fixed value (1-bit), mode status output (1-bit), switch status output (22-bit), and CRC (8-bit).

Transmission and reception discrimination (2-bit) is intended to discriminate transmit and receive frame. The interrupt factor is discussed on Page 19. When an interrupt factor occurs, the corresponding bit becomes "1". Mode status (1-bit) is "0" when set to normal mode, and it is "1" when set to sleep mode. Switch status output (22-bit) is "1" when external switch is ON, and it is "0" when external switch is OFF. The CRC (8-bit) outputs the result of a 39 to 8 bit CRC calculation.

The switch status is latched to the timing of CSB falling edge. The then in order of interrupt factor output, mode status and switch status output are output from SO by SCLK rising.

Table 14. Serial Data Output (SO-Switch Status (Output)	
--	---------	--

Output frame	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	1
SO output bit	1	0	0		Interrup	ot facto	r output	t	0	Mode		Switch	INB5-0	status	output		L
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
			Switch	INA7-0) status	output				•	Switch	INZ7-0) status	output			CRC

The register value output bit alignment is a 40-bit structure composed of transmission and reception discrimination (2-bit), a fixed value (1-bit), interrupt factor output (5-bit), register value output (24-bit), and CRC (8-bit).

The data is output by SO at SCLK's rising edge after the CSB falling edge of the command following the register value output command.

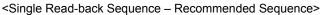
The bit alignment of the register value output is shown on Table 37. The sequence of register value output is shown in Figure 11 and Figure 12.

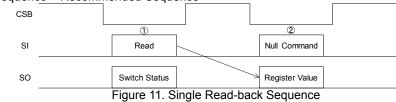
Table 15. Serial Data Output (SO-Register Value Output)

	Table		Sella	ai Dai	a Ou	ւրսւ (<u>30-n</u>	eyisi	ei va	iue O	uipui	.)					
Output frame	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
SO output bit	1	0	0		Interrup	ot facto	r output	t			Reg	gister va	alue ou	itput			
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
							Red	, gister va	alue ou	tput							CRC

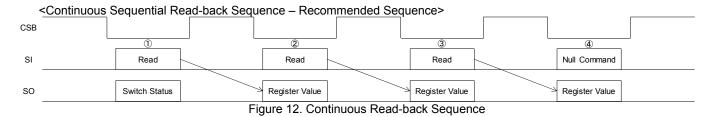
The register value output command (Table 38 RIER to RMDR) is used to read-back the register value written by register write command (Table 37 IER to MDR).

Figure 11 describes the single read-back sequence. Figure 12 describes the continuous read-back sequence.





- ① Send the register value output command.
- The switch status is output by SO.
- ② Read the register value by sending the Null command. The result of the register value output command ① is output by SO.



- ① Send the register value output command.
- The switch status is output by SO.
- 2 Send the register value output command following ①. (The address of the register value output command does not need to be the next address.)
- ③ Send the register value output command repeatedly as needed.
- The SO output at each command is the result of the previous register value output command. (4) Send the Null command in the end.
- The register value of the previous register output command is output by SO.
- 3. Switch Status Output

Switch status can be sent through SO output.

4. Interrupt (INTB operation)

There are five interrupt factors that cause the INTB terminal to output an "L". The type of interrupt factor that occurred can be checked in the SO output when CSB is "L".

INTB output will return to "H" once the interrupt factor is cleared by the rising edge of CSB. The INTB terminal is an open-drain output that is internally pulled-up to VDDI.

Interrupt Factors

I

The interrupt factors are shown below:

Interrupt Factor	Interrupt flag (SO output)	Flag name
① Test detection	SO output bit [36]	: "test_flg"
② Thermal shutdown detection	SO output bit [35]	: "them_flg"
 Reset detection 	SO output bit [34]	: "rst_flg"
④ Communication error detection	SO output bit [33]	: "err_flg"
(CRC error, 40-bit frame error, or transmission and rec	eption discrimination error)	
5 Switch status change detection	SO output bit [32]	: "sw_flg"

1 Test detection

The IC generates an interrupt after a transition to test mode. The TEST terminal should always be connected to ground.

2 Thermal shutdown detection

Interrupt occurs when the thermal shutdown circuit detects a temperature higher than the allowable junction temperature inside IC.

③ Reset detection

Interrupt occurs after the activation of Power on Reset (POR) or the transmission of the reset command. Upon POR activation, the SO output interrupt flag "rst_flg" is reflected instantly. With reset command transmission, "rst_flg" is reflected on the next command transmission.

(4) Communication error detection

Interrupt occurs due to either a CRC error, a 40-bit frame error, or a command transmission error. The interrupt flag "err_flg" is triggered by the following:

CRC error: when there is a Cyclic Redundancy Check error40-bit frame error: when the command received is not 40-bitTransmit and receive determination error: when the first two bits of the command received is not [39:38]="01"

(5) Switch status change detection

Interrupt occurs when switch a status changes (switch-ON→OFF or switch-OFF→ON).

· Clearing of INTB output and interrupt factor

The INTB "L" output and the interrupt factor are both cleared by the CSB rising edge during command transmission. In case a new interrupt factor occurs during command transmission, the interrupt factor is not cleared. The new interrupt factor is reflected on the next command transmission.

The interrupt factor is not cleared by the register readout that follows the register value output command.

5. Operating Modes

BD3375MUV-M has two types of operating mode, the normal and the sleep mode. Transition between the two modes can be done by sending the correct "Monitor Mode Transition Command". The current mode of operation can be checked through the WAKEB and the SO terminal outputs.

Monitor Mode Transition register address (0x4F): Bit [31]: 0=Normal mode, 1=Sleep mode)

Normal Mode

Normal mode operation can be set to continuous monitoring, wherein the switch status is checked by a continuously ON current source, or to intermittent monitoring, wherein the switch status is checked by a regularly ON/OFF current source. The period of intermittent monitoring ^(Note 20) can be set according to power supply system while strobe time ^(Note 21) is common for all switch terminals.

At normal mode, WAKEB is "L" and the 30-bit of the SO output is "0".

Sleep Mode

Sleep mode operation, like in normal mode, can be set to continuous monitoring or intermittent monitoring. The monitoring period ^(Note 20) of intermittent monitoring can be set according to power supply system. The strobe time ^(Note 21) is common for all switch terminals and both modes.

The difference with normal mode is that, from sleep mode, it is possible to change to normal mode automatically when interrupt occurs. (Automatic mode transition function)

At sleep mode, WAKEB is in "Hi-Z" state and its voltage level is the level of the external pull-up. The 30-bit of SO output is "1" at sleep mode.

(Note 20) Monitor period (Note 21) Strobe time

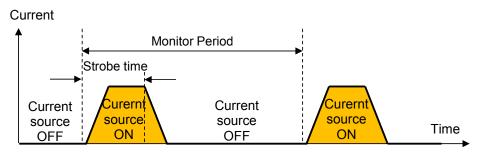


Figure 13. Intermittent Monitoring

6. Automatic Mode Transition Function

By sending the "Automatic Mode Transition Command" through setting the MIR register (0x4E) to "1", automatic transition from sleep to normal mode is possible. The conditions for a change in mode from sleep to normal to occur for both enabled and disabled "Automatic Mode Transition Function" are shown below:

· Conditions for sleep to normal mode transition when "Automatic Mode Transition Function" is enabled:

- 1. Normal mode transition command is sent
- 2. POR occurs or reset command sent (Initialization)
- 3. A switch status changes (The "Switch Change Interrupt Setting" should be enabled)

· Conditions for sleep to normal mode transition when "Automatic Mode Transition Function" is disabled:

- 1. Normal mode transition command is sent
- 2. POR occurs or reset command sent (Initialization)

[Extension Function1: Intermittent Monitoring at the Same Time (with Current Slope)]

In intermittent monitoring, it is possible to detect the status of the all switches at the same time. When all inputs are set to detect the switch status by intermittent monitoring, the wetting current has a rising and falling slope.

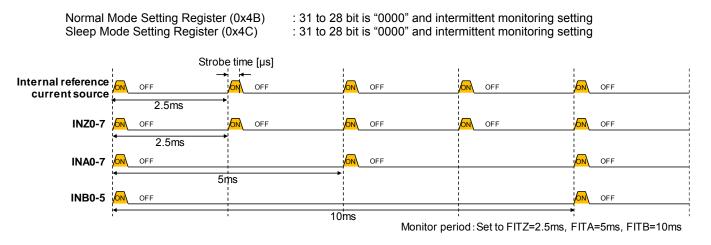
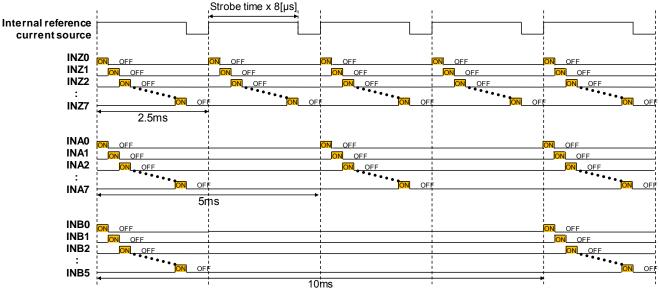


Figure 14. Intermittent Monitoring at the Same Time Example

[Extension Function 2: Sequential Monitoring by Power Supply System]

In this type of sequential monitoring, the status of the switches within a power supply system is monitored one at a time. This type has no slope. Since no two or more current sources in a power supply system are ON at the same time, radiation noise is reduced.



Monitor period: Set to FITZ=2.5ms, FITA=5ms, FITB=10ms

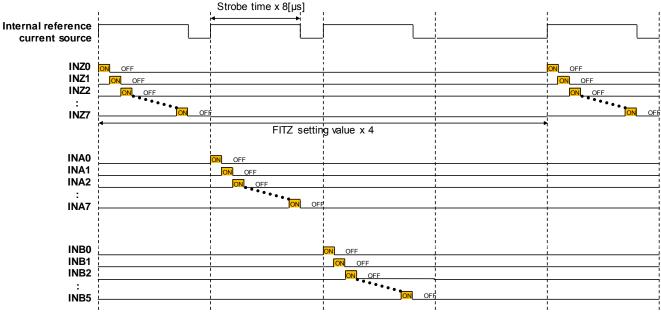
Figure 15. Sequential Monitoring by Power Supply System Example

[Extension Function 3: Sequential Monitoring of All Switch Terminals]

In this type of sequential monitoring, the status of all switches is monitored one at a time.

Since no two or more current sources are ON at the same time, radiation noise is reduced. This type has no slope.

The monitoring period for all switches increases by four times the monitoring period set for the INZ channels as shown in Figure 16. Uniform sequential monitoring and sequential monitoring by power supply should not be enabled at the same time. In case the two sequential monitoring methods are activated simultaneously, the method which prevails is uniform sequential monitoring.



Monitor period: Set to FITZ=2.5ms, FITA=5ms, FITB=10ms

Figure 16. Sequential Monitoring of All Switches Terminals Example

7. WAKEB Terminal

WAKEB is an open drain output pin. In normal mode, its output is "L". In sleep mode, its output is "Hi-Z" and its voltage level is the level of the external pull-up.

8. Source/Sink Current Source for Switch Terminal

There are three types of switch terminal inputs with internal current source: INZ, INA, and INB. The current level can be set for each switch terminal.

- Current Source of INZ system (INZ0 INZ7)
 This current source is used to source or sink current to the external switch. The wetting current can be interchanged between pull-up and pull-down. VPUA is the power supply for the pull-up current source.
- Current Source of INA (INA0 INA7)
 This current source is used to source current to the external switch. VPUA is the power supply
- Current Source of INB (INB0 INB5)
 This current source is used to source current to the external switch. VPUB is the power supply.

The current source settings can be fixed by INZ current source/sink selection command, the current source setting command, and the holding current/wetting current value setting command.

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9. Wetting Current Timer

The wetting current timer is 13ms to 22ms. This function can be enabled individually for each switch terminal. The timer starts after the switch has been detected as ON. After the 13ms to 22ms timer is finished, the wetting current (10mA/15mA) is switched to holding current (1mA/3mA/5mA). The timer is reset after the switch is turned OFF.

[Function operation1] Wetting Current Timer (Continuous Operation)

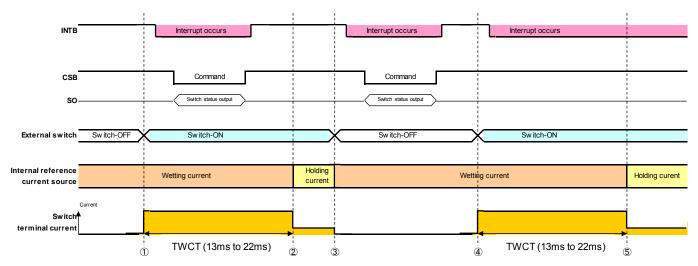


Figure 17. Wetting Current Timer (Continuous Operation)

- ① Switch change occurs (OFF \rightarrow ON), IC detects switch status change.
- 2 When ON state of the switch continues for more than 13ms to 22ms, the holding current is output.
- (3) Switch change occurs (ON \rightarrow OFF).
- (4) Switch change occurs (OFF \rightarrow ON), IC detects switch status change.
- 5 When ON state of the switch continues for more than 13ms to 22ms, the holding current is output.

[Function operation2] Wetting Current Timer (Intermittent Monitoring)

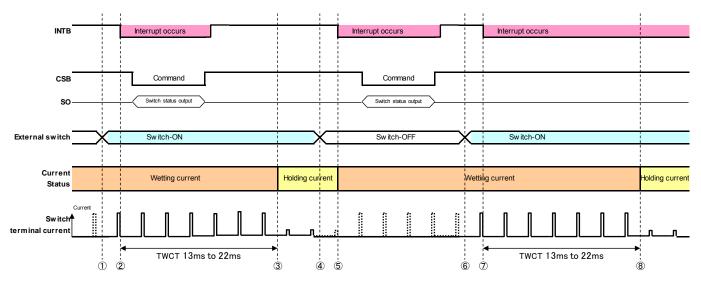


Figure 18. Wetting Current Timer (Intermittent Monitoring)

- ① Switch change occurs (OFF \rightarrow ON)
- 2 IC detects switch status change.
- ③ When ON state of the switch continues for more than 13ms to 22ms, the holding current is output.
- ④ Switch change occurs ($ON \rightarrow OFF$).
- 5 IC detects switch status change, switch current is switched from holding current to wetting current.
- 6 Switch change occurs (OFF \rightarrow ON).
- IC detects switch status change.
- (8) When ON state of the switch continues for more than 13ms to 22ms, the holding current is output.

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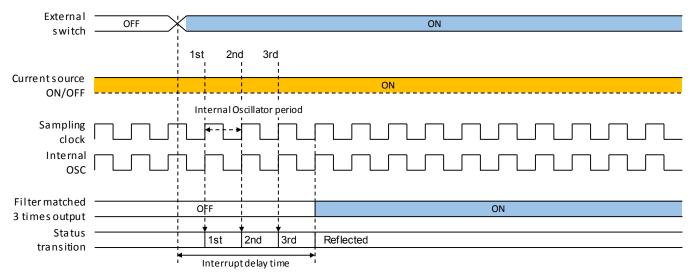
10. n-Times Matched Filter

All switch inputs have built-in "1 to 6 times matched filters". This function can filter the ON/OFF switch status judgment made by the internal comparator. The filter function can be enabled for each power supply system. If the register has been updated during the counting of the filter, the counting is not reset.

If the monitoring method is continuous monitoring, the switch state is filtered n times (n: 1 to 6) multiplied by the period of the internal oscillator (32 kHz).

If the monitoring method is intermittent monitoring, the switch state is filtered n times (n: 1 to 6) multiplied by the monitoring period.

• Set to full-time monitor : Sampling period is internal oscillator period : 31.25µs (Typ)

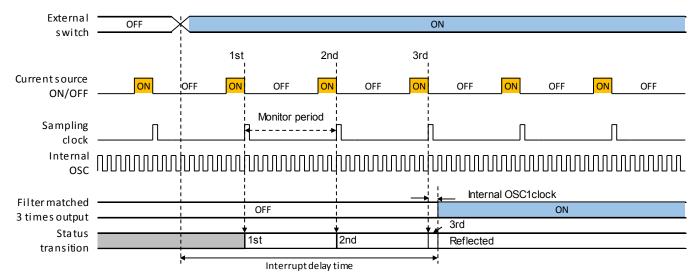


Time from Monitoring to End of Filtering:

{Monitoring Period x (Filter Number of Times -1) + Period of Internal Oscillator} to {Monitoring Period x (Filter Number of Times) + Period of Internal Oscillator}

Figure 19. 3 Times Matched Filter Operation on Continuous Monitoring

• Set to intermittent monitor : Sampling monitor period is common with monitor period.



Time from Monitoring to End of Filtering:

{Monitoring Period x (Filter Number of Times -1) + Period of Internal Oscillator} to {Monitoring Period x (Filter Number of Times) + Period of Internal Oscillator}

Figure 20. 3 Times Matched Filter Operation on Intermittent Monitoring

11. Digital Multiplexer Output (DMUX)

The status of the selected switch input is reflected by the DMUX terminal. DMUX takes the output of the comparator on a timing determined by the monitoring method. Only one switch terminal at a time can be selected to be reflected by DMUX.

When no switch is selected, the output of DMUX is "L".

12. Input Threshold Voltage of Switch Terminal

The switch input threshold voltage is a fraction of the AVDD voltage. It can be set to 3.0V or to 4.0V.

- 3.0V Setting : V_{TH3}=AVDDx0.6 (8.0V≤VPUB≤26V)
- 4.0V Setting : V_{TH4} =AVDDx0.8 (8.0V≤VPUB≤26V)

Table 16. Relationship between the Switch Input Threshold Voltage and the SO Output

Input type	Source or Sink	Input Voltage	Comparator output	SO serial interface bit
	Source	INZ <threshold< td=""><td>0</td><td>Н</td></threshold<>	0	Н
	Source	INZ>Threshold	1	L
INZ	Sink	INZ <threshold< td=""><td>0</td><td>L</td></threshold<>	0	L
	Sink	INZ>Threshold	1	Н
	N/A	INA,INB <threshold< td=""><td>0</td><td>Н</td></threshold<>	0	Н
INA,INB	N/A	INA,INB>Threshold	1	L

13. Over-temperature Protection Circuit

When the junction temperature of the IC becomes higher than the thermal limit 160°C (Typ), interrupt (INTB="L") occurs and the source/sink current through the switch terminals is switched to 1mA (Min). The MCU is notified by the SO over-temperature detection flag (them_flg) changing to "1" that an irregularity in temperature has occurred. When the junction temperature of the IC has fallen below 140°C (Typ), interrupt is cleared on the next command transmission and the wetting current level returns to what was set on the registers.

Notice: The over-temperature detection value, 155°C to 175°C, and the hysteresis temperature, 10°C to 30°C, were not tested in shipment test. Also, the over-temperature protection circuit operates beyond the absolute maximum temperature ratings so the IC should not be used in a system where activation of the said protection function is expected.

14. Cyclic Redundancy Check (CRC)

The 7-0th bit of both the transmitted and received communication frame of the IC is the cyclic redundancy check (CRC), which is responsible for the detection of a data communication error.

If the IC received a CRC error, asserts interruption (INTB="L") and error flag ("err_flg") to SO output. SO output becomes "H" on the next communication to notify the MCU of the error. A command that has a CRC error is not a valid command.

The CRC generation polynomial is $X^8 + X^5 + X^4 + 1$.

Command Description

Each Command has two types of functions. One is to write a value to a register. The other is to read back the register value which was written by the write command. The function to be used is set by the 37-bit of each command. (The Null and Reset commands don't include the register value output command because they don't write in the registers.)

In the command descriptions below, the Write Command is for writing a value to a register and the read command is for reading back a register value.

1. Null Command

This command is a read only command that allows the user to monitor interruption and switch status.

					Table	e 17. I	Null C	Comm	nand									
Command				R	egister	addres	ss						Settin	g data				
0:"L", 1:"H", x: don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Null Command (Read Only)	IRC	0	1	0	0	0	0	0	0	х	х	х	х	х	х	х	х	
									Settin	g data								CRC
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
		х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	CRC

2. Interrupt Notification of Switch Change Setting Command

This command allows the user to configure interrupt sources for the INTB pin.

Specifically, this command allows the user to individually configure which switches trigger an interrupt on INTB by enabling or disabling the IEBn, IEAn, and IEZn setting bits shown below.

The SO output will return the switch status depending on the settings stored at the next CSB falling edge.

Table 18. Interrupt Notification of Switch Change Setting Command

Command			R	egister	addres	ss						Settin	g data				
0:"L", 1:"H", x: don't care	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Interrupt Notification of Switch Change Setting IER	0	1	W/R	0	0	0	0	1	х	х	IEB5	IEB4	IEB3	IEB2	IEB1	IEB0	
								Settin	g data								CRC
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
	IEA7	IEA6	IEA5	IEA4	IEA3	IEA2	IEA1	IEA0	IEZ7	IEZ6	IEZ5	IEZ4	IEZ3	IEZ2	IEZ1	IEZ0	CRC
IEBn (n: 5-0) [Default: 1]		0: C)isabl	ed		1:	Enab	led	tus Cl	•							
IEAn (n: 7-0) [Default: 1]			rrupt)isabl		icatio		Switch Enabl		us Cl	hange	e for l	NA S	Syster	n			
IEZn (n: 7-0) [Default: 1]			rrupt)isabl		icatio		Switch Enabl		tus Cl	hange	e for l	NZ S	Syster	n			
W/R		<u> </u>	gister Vrite	Write	e/Rea		ting Read										

3. Comparator Operation Control Command

This command allows the user to individually enable or disable the switch terminal comparator for each switch input. When a switch input's comparator is disabled through this register, both the corresponding settings available for that switch input within the "Interrupt Notification of Switch Change Setting Command" and the "Source/Sink Current Setting Command" are invalid.

When the comparator is active, the switch status output does not depend on whether the wetting current is set to source or sink. The switch status output is "1" when the switch is ON and "0" when the switch is OFF. When the comparator is set to disabled, the switch status is undefined.

		Table	e 19. (Comp	arato	or Op	eratic	n Co	ntrol	Comr	mand							
Command				R	egister	addres	ss						Settin	g data				
0:"L", 1:"H", x don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Comparator Operation Control	CMR	0	1	W/R	0	0	0	1	0	х	х	CMB5	CMB4	CMB3	CMB2	CMB1	CMB0	
									Settin	g data								CRC
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
		CMA7	CMA6	CMA5	CMA4	CMA3	CMA2	CMA1	CMA0	CMZ7	CMZ6	CMZ5	CMZ4	CMZ3	CMZ2	CMZ1	CMZ0	CRC
CMBn (n: 5-0) [Default: 1] CMAn (n: 7-0) [Default: 1] CMZn (n: 7-0) [Default: 1]		0: [Cor 0: [Cor	mpara Disab mpara Disab mpara Disab	led ator C led ator C	' Opera	1: ation f 1: ation f	Enat for IN Enat	oled A Sys oled Z Sys	stem									
W/R			gister Nrite	Write	e/Rea		tting Read	ł										

T-1-1- 40 0

4. Comparator Threshold Selection Command

This command allows the user to set the comparator threshold of the switch terminals.

Switch detection threshold selection is available for each power supply system (See CTB, CTA, CTZ settings shown below).

Command				R	egister	addre	SS						Settin	g data				
0:"L", 1:"H", x don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Comparator Threshold Selection	CTR	0	1	W/R	0	0	0	1	1	СТВ	CTA	CTZ	х	х	х	х	х	
									Settin	g data								CRC
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
		х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	CRC
CTB [Default: 0]			Cor 0: 3	•	ator T	hrest		or INI 4.0V	3 Sys	tem								
CTA [Default: 0]			Cor 0: 3		ator T	hrest		or IN/ 4.0V	A Sys	tem								
CTZ [Default: 0]			Cor 0: 3		ator T	hresh		or INZ 4.0V	Z Sys	tem								
W/R				gister Vrite	Write	e/Rea		tting Read										

Table 20. Comparator Threshold Selection Command

5. INZ Current Source/Sink Selection Command

This command allows the user to select the current configuration, whether source (internal pull-up current source) or sink (internal pull-down current source), through the INZ input switch terminals.

	Tal	ble 2	1. INZ	Z Curi	rent S	Sourc	e/Sin	k Sel	ectior	ו Con	nman	d					
Command			R	egister	addre	SS						Settin	g data				
0:"L", 1:"H", x: don't care	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
INZ Current Source/Sink Selection PUDR	0	1	W/R	0	0	1	0	0	х	х	х	х	х	х	х	х	
								Settin	g data								CRC
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
	х	х	х	х	х	х	х	х	PUD7	PUD6	PUD5	PUD4	PUD3	PUD2	PUD1	PUD0	CRC
PUDn (n: 7-0) [Default: 0]		0: S 1: S	Source Sink (I	e (Inte ntern	ernal al Pu	Pull-u	սp Cւ vn Cւ	urrent	ysten Sour Sour	ce)							
W/R			gister Vrite	vvrite	/Rea		ting Read										

6. Current Source Activation Command

This command allows the user to enable or disable the wetting current sources at the switch input terminals. The current sources can be set to ON or OFF per power supply system.

The output current level is determined by the "Holding Current / Wetting Current Value Setting Command" discussed in section 7 below.

If an external current source is used, the comparator should be enabled (see section 3 above) and the internal current source should be disabled using this register.

		Tabl	e 22.	Curre	ent Se	ource	e Activ	/ation	l Com	iman	d						
Command			R	egister	addres	ss						Settin	g data				
0:"L", 1:"H", x don't care	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Current Source Activation C	ER 0	1	W/R	0	0	1	0	1	CEB	CEA	CEZ	х	х	х	х	х	
								Settin	g data								CRC
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	CRC
CEB [Default: 0]		Cur 0: 0	rent S	Sourc	es of		Syste ON	em									
CEA [Default: 0]			rent S	Sourc	es of	INA		m									
CEZ [Default: 0]		Cur	rent s	sourc	e of I	NZ S	ysten	ı									
W/R			DFF gister Vrite	Write	e/Rea	d Set	ON tting Read										

Table 22.	Current	Source Activation	Command
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7. Holding Current / Wetting Current Level Selection Command

This command allows the user to select the output level of each current source. This command also has arguments to set both the holding and the wetting current.

The holding current can be set to 1mA, 3mA, or 5mA.

The wetting current can be set to OFF ("Hi-Z"), 1mA, 3mA, 5mA (set to holding current), 10mA, or 15mA. Unlike holding current, wetting current output levels can be set individually for each switch terminal.

lable	23. H	Iolain	g Cu	Table 23. Holding Current / Wetting Current Level Selection Command (LSB)														
Command		Register address Setting data																
0:"L", 1:"H", x don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Holding Current / Wetting Current Level Selection (LSB)	LCR	0	1	W/R	0	0	1	1	0	CRH1	CRH0	LCB5	LCB4	LCB3	LCB2	LCB1	LCB0	
		Setting data																CRC
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
	Ī	LCA7	LCA6	LCA5	LCA4	LCA3	LCA2	LCA1	LCA0	LCZ7	LCZ6	LCZ5	LCZ4	LCZ3	LCZ2	LCZ1	LCZ0	CRC

Table 22 Holding Current / Motting Current Loval Salection Co

Table 24. Holding Current / Wetting Current Level Selection Command (MSB)

Command				R	egister	addres	ss				Setting data									
0:"L", 1:"H", x: don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24			
Holding Current / Wetting Current Level Selection (MSB)	MCR	0	1	W/R	0	0	1	1	1	х	х	MCB5	MCB4	MCB3	MCB2	MCB1	MCB0			

	Setting data															CRC
23	23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8															7-0
MCA7	MCA6	MCA5	MCA4	MCA3	MCA2	MCA1	MCA0	MCZ7	MCZ6	MCZ5	MCZ4	MCZ3	MCZ2	MCZ1	MCZ0	CRC

CRH [1:0]	[Default: 00]	Holding Current Value	
		00: 1mA	01: 3mA
		10: 5mA	11: 1mA
{MCBn (n: 5-0), LCBn (n: 5-0)}	[Default: 01]	Wetting Current Value for	INB System
		00: Invalid(Hi-Z)	01: 1/3/5mA(Holding Current Value)
		10: 10mA	11: 15mA
{MCAn (n: 7-0), LCAn (n: 7-0)}	[Default: 01]	Wetting Current Value for	INA System
		00: Invalid(Hi-Z)	01: 1/3/5mA(Holding Current Value)
		10: 10mA	11: 15mA
{MCZn (n: 7-0), LCZn (n: 7-0)}	[Default: 01]	Wetting Current Value for	INZ System
		00: Invalid(Hi-Z)	01: 1/3/5mA(Holding Current Value)
		10: 10mA	11: 15mA
W/R	Register Write/F	Read Setting	
	0: Write	1: Read	

8. Wetting Current Operation Control Command

This command allows the user to enable or disable the "wetting current timer".

This "wetting current timer" counts 13 to 22ms after the switch has been closed and the wetting current changes to holding current (1mA/3mA/5mA). The timer is reset when the switch is turned off.

If the wetting current level is the same as the holding current level, the timer does not operate.

The wetting current timer can be enabled or disabled individually for each switch terminal.

~

Table 25. Wetting Current Operation Control Command																		
Command				R	egister	addres	s						Settin	g data				
0:"L", 1:"H", x don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Wetting Current Operation Control	WTR	0	1	W/R	0	1	0	0	0	х	х	WTB5	WTB4	WTB3	WTB2	WTB1	WTB0	
			Setting data										CRC					
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
		WTA7	WTA6	WTA5	WTA4	WTA3	WTA2	WTA1	WTA0	WTZ7	WTZ6	WTZ5	WTZ4	WTZ3	WTZ2	WTZ1	WTZ0	CRC

. .

...

WTBn (n: 5-0) [Default: 0]	Wetting Current Timer for INB System 0: Disabled 1: Enabled
WTAn (n: 7-0) [Default: 0]	Wetting Current Timer for INA System
	0: Disabled 1: Enabled
WTZn (n: 7-0) [Default: 0]	Wetting Current Timer for INZ System
	0: Disabled 1: Enabled
W/R	Register Write/Read Setting
	0: Write 1: Read

9. n-Times Matched Filter Activation Control Command

This command allows the user to enable or disable the n-times matched LPF.

If this function is enabled, the switch output is updated only after the comparator output has been sampled "n" times (where n = 1 to 10) and if all sampled comparator outputs match.

This command allows for each switch terminal to be enabled or disabled individually.

Command	Register address												Settin	g data				
0:"L", 1:"H", x don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
n-Times Matched Filter Activation Control	DFR	0	1	W/R	0	1	0	0	1	DFB2	DFB1	DFB0	DFA2	DFA1	DFA0	DFZ2	DFZ1	
	Γ								Settin	g data								CRC
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
		DFZ0	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	CRC
	001		<u>.</u> т		Mata			-			Cta							
DFB [2:0] [Default: 00	UUJ	n-Times Matched LPF Settings for INB System																
		000 : Disabled (1 time) 001 : 2 times 010 : 3 times 011 : 4 times																
			010			times times					-		-					
											10		-	6 time				
			110		: D	sable	ed (1	time)			11	1	:	Disat	bled (1 tim	e)	
DFA [2:0] [Default: 00	00]		n-T	imes	Matc	hed L	.PF S	etting	is for	INA	Syste	m						
	-		000)	: D	sable	ed (1	time)			00)1	::	2 time	es			
			010)	: 3	times	;				011 : 4 times							
			100)	: 5	times	;				10)1	: (
		110: Disabled (1 time)111: Disabled (1 time)										e)						
DFZ [2:0] [Default: 00	າດາ		n-T	imes	Mate	hed I	PF S	ettinc	is for	IN7	Svste	m						
	50]		000					time)			00			2 time	29			
			010			times		unic)			01			4 time				
		100		-	times					10			6 time					
110 : Disabled (1 time) 111										Disat		1 tim	e)					
W/R			Doc	viotor	\\/ritc		4 6 4	tina										
				gister	vvnite	, Rea		•										
			U: V	Vrite			1:1	Read										

Table 26. n-Times Matched Filter Activation Control Command

10. DMUX Setting Command

This command allows the user to enable/disable and configure selected switch output on the DMUX terminal. The result of the chosen switch terminal's comparator is taken and output to DMUX using timing that depends on the monitoring method used.

Any switch input terminal can be connected to this DMUX pin by adjusting the DMX0 to DMX4 bits shown below.

				Tabl	le 27.	DML	JX Se	etting	Com	manc	ł							_
Command				R	egister	addres	SS						Settin	g data				
0:"L", 1:"H", x don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
DMUX Setting	DMR	0	1	W/R	0	1	0	1	0	DMX4	DMX3	DMX2	DMX1	DMX0	х	х	х	
			Setting data												CRC			
		23	23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8											7-0				

Table 27. [DMUX Setting	g Command
-------------	--------------	-----------

Table 28.	DMUX Channel Selection
31-27 bit	Selected Channel
00000	Disabled (Output is "L")
00001	INZ0
00010	INZ1
00011	INZ2
00100	INZ3
00101	INZ4
00110	INZ5
00111	INZ6
01000	INZ7
01001	INA0
01010	INA1
01011	INA2
01100	INA3
01101	INA4
01110	INA5
01111	INA6
10000	INA7
10001	INB0
10010	INB1
10011	INB2
10100	INB3
10101	INB4
10110	INB5
10111-11111	Disabled (Output is "L")

Table 20 DMUX Cha 0-1----اممم

х

х х х

х

х

х

х х х

х

CRC

х

х

х

х

х

DMX [4:0] [Default: 00000]

DMUX Terminal Setting

00000 : Disabled (DMUX output is "L") 00001 - 10110 : Selected Channel : Disabled (DMUX output is "L") 10110 - 11111 Register Write/Read Setting 0: Write 1: Read

W/R

11. Normal Mode Setting Command

This command allows the user to set the monitoring period, strobe time, and monitoring method of normal mode.

The normal mode is set after power on reset or by "Monitor Mode Transition Command".

The monitoring period can be set individually per power supply system but the strobe time is common to all switch terminals. The monitoring method can be set continuous monitoring, intermittent monitoring at the same time, sequential monitoring by power supply system and sequential monitoring of all switch terminals.

Continuous Monitoring:

IC monitors switch status continuously.

Refer to the "[Basic Operation 1] Detection of switch status change (Continuous Monitoring)" section for additional details.

Intermittent Monitoring at the Same Time:

IC monitors switch status per power supply system at the same time.

Refer to the "[Extension Function1: Intermittent Monitoring at the Same Time (with Current Slope)]" section for additional details.

Sequential Monitoring by Power Supply System:

IC monitors switch status per switch by turns on power supply system.

Refer to the "[Extension Function 2: Sequential Monitoring by Power Supply System]" section for additional details. • Sequential Monitoring of All Switch Terminals:

IC monitors switch status per switch by turns. Refer to the "[Extension Function 3: Sequential Monitoring of All Switch Terminals]" section for additional details.

If both sequential and continuous monitoring are enabled at the same time, continuous monitoring will be the one implemented.

If both sequential monitoring by power supply system and sequential monitoring of all switch terminals are enabled at the same time, sequential monitoring of all switch terminals will be the one implemented.

Command			R	Register address						Setting data													
0:"L", 1:"H", x: don't care	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24							
Normal Mode Setting FMR	0	1	W/R	0	1	0	1	1	FSQ	FSQB	FSQA	FSQZ	FITB2	FITB1	FITB0	FITA2							
								Settin	g data								CRC						
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0						
	FITA1	FITA0	FITZ2	FITZ1	FITZ0	SVW1	SVW0	FITB3	FITA3	FITZ3	х	х	х	х	х	х	CRC						
FSQ [Default: 0]				Sequential Monitoring of All Switch Terminals 0: Disabled 1: Enabled																			
FSQB [Default: 0]				Sequential Monitoring by Power Supply System for INB System																			
FSQA [Default: 0]										0: Disabled 1: Enabled Sequential Monitoring by Power Supply System for INA System 0: Disabled 1: Enabled													
FSQZ [Default: 0]	SQZ [Default: 0]								Sequential Monitoring by Power Supply System for INZ System 0: Disabled 1: Enabled														
FIT*[3:0] (*: B, A, Z) [Defa	FIT*[3:0] (*: B, A, Z) [Default: 0000]							Monitoring Period for Normal Mode 0000: Continuous Monitoring 0001: 2.5ms 0010: 5ms 0011: 10ms 0100: 20ms 0101: 30ms 0110: 40ms 0111: 50ms 1000: 100ms 1001 – 1111: Setting prohibited															
SVW [1:0] [Default: 01]	SVW [1:0] [Default: 01]								Strobe Time 00: 93.75µs 01: 125µs 10: 187.5µs 11: 250µs														
W/R	W/R								Register Write/Read Setting0: Write1: Read														

Table 29. Normal Mode Setting Command

12. Sleep Mode Setting Command

This command allows the user to set the monitoring period and monitoring method of sleep mode.

The sleep mode is set by "Monitor Mode Transition Command".

The strobe time of sleep mode is the same as the normal mode.

About the monitoring period and monitoring method, refer to the "Normal Mode Setting Command" discussed in section 11 below.

Table 30. Sleep Mode Setting Command																	
Command			R	egister	addres	s						Settin	g data				
0:"L", 1:"H", x don't care	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Sleep Mode Setting SMR	0	1	W/R	0	1	1	0	0	SSQ	SSQB	SSQA	SSQZ	SITB2	SITB1	SITB0	SITA2	
		Setting data												CRC			
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
	SITA1	SITA0	SITZ2	SITZ1	SITZ0	х	х	SITB3	SITA3	SITZ3	х	х	х	х	х	х	CRC
SSQ [Default: 0] SSQB [Default: 0] SSQA [Default: 0] SSQZ [Default: 0] SIT*[3:0] (*: B, A, Z) [Defa	0: Disabled 1: Enabled SSQB [Default: 0] 0: Disabled 1: Enabled SSQA [Default: 0] 0: Disabled 1: Enabled SSQA [Default: 0] 0: Disabled 1: Enabled SSQA [Default: 0] 0: Disabled 1: Enabled 0: Disabled 1: Enabled												tem				
W/R	W/R							Monitoring Period for Sleep Mode0000: Continuous Monitoring0001: 2.5ms0010: 5ms0011: 10ms0100: 20ms0101: 30ms0110: 40ms0111: 50ms1000: 100ms1001 – 1111: Setting prohibitedRegister Write/Read Setting0: Write1: Read									

13. Detection Edge Selection Command

This command allows the user to configure interrupt trigger of switches for the INTB pin. The interrupt trigger can be set to only the falling edge (Note 22) or both the rising and falling edges of the switch input voltage per power supply system.

If only the falling edge is selected, the INTB pin not changes by the rising edges of switch input voltage. (Note 22) If the INZ current "Source Setting" is enabled, the falling edge of the switch input terminal is seen when the external switch is turned on. If the INZ current "Sink Setting" is enabled, the falling edge is seen when the external switch is turned off.

Command					R	egister	addre	ss			Setting data								
0:"L", 1:"H", x: don't care			39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Detection Edge	Selection	ISR	0	1	W/R	0	1	1	0	1	ISB	ISA	ISZ	х	х	х	х	х	
		Setting data																	
			23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	
			х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	
ISA ISZ	[Default: [Default:			Switch edge where interrupt occurs for INB System 0: Only Falling Edge 1: Both Edges Switch edge where interrupt occurs for INA System 0: Only Falling Edge 1: Both Edges Switch edge where interrupt occurs for INA System 0: Only Falling Edge 1: Both Edges Switch edge where interrupt occurs for INZ System 0: Only Falling Edge 1: Both Edges															
W/R				0: Only Falling Edge 1: Both Edges Register Write/Read Setting 0: Write 1: Read															

14. Automatic Mode Transition Command This command allows the user to configure the mode to automatically change by a change in switch status. If the automatic transition is enabled, the monitoring period and monitoring method are changed to normal mode settings when it detects a change in switch status on sleep.

Refer to the "[Basic Operation 4] Sleep Mode Operation Automatic Transition to Normal Mode" section for additional details on how sleep mode operations works for this IC.

Command		Register address Setting data																
0:"L", 1:"H", x: don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Automatic Mode Transition	MIR	0	1	W/R	0	1	1	1	0	MR_IER	х	х	х	х	х	х	х	
									Settin	g data								
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	
		х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	

IER [Default: 1]	Automatic Mode	Transition
	0: Disabled	1: Enabled
	Register Write/R	lead Setting
	0: Write	1: Read

15. Monitor Mode Transition Command

MR W/R

This command allows the user to change the mode of operation between normal and sleep. Refer to the "[Basic Operation 3] Sleep Mode Operation (Manual Transition)" section for additional details on how sleep mode operations works for this IC.

			Table	e 33. I	Monit	or Mo	ode T	ransi	tion C	Comm	and							
Command				R	egister	addres	ss											
0:"L", 1:"H", x don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Monitor Mode Transition	MDR	0	1	W/R	0	1	1	1	1	MDC	х	х	х	х	х	х	х	
		Setting data																CRC
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
		х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	CRC
MDC [Default: 0]	·	Monitoring mode 0: Normal Mode 1: Sleep Mode																
W/R			Reg	jister	Write	/Rea	d Set	ting										
			0: V	Vrite			1:	Read										

16. Reset Command

This command allows the user to reset the registers to their initial settings. After the reset command has been sent, the physical interrupt pin goes to low (INTB="L").

Table 34. Reset Command																	
Command		Register address Setting data															
0:"L", 1:"H", x: don't care	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Reset RST	0	1	0	1	1	1	1	1	х	х	х	х	х	х	х	х	
								Settin	g data								CRC
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	CRC

17. TEST Command

This command is used to enter test mode, which is only possible when the TEST pin is "H".

	Table 35. TEST Command																		
	Command				R	egister	addres	ss											
0:"L",	1:"H", x: don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
	TEST TSR			1	1	1	1	0	0	1	TSS7	TSS6	TSS5	TSS4	TSS3	TSS2	TSS1	TSS0	
										Settin	g data								CRC
			23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
			х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	CRC

18. Register Map

<u></u>							Та	ble	36.	Reg	giste	er N	lap														
Register Name	Symbol	Register Address												etting D ef*: Defa													CRC
		39:32	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7:0
Null Command	IRC	0x40																									CRC
Interrupt Notification of Switch Change Setting Command [Default: Valid]	IER	0x41			IEB5 (def:1)	IEB4 (def:1)	IEB3 (def:1)	IEB2 (def:1)	IEB1 (def:1)	IEB0 (def:1)	IEA7 (def:1)	IEA6 (def:1)	IEA5 (def:1)	IEA4 (def:1)	IEA3 (def:1)	IEA2 (def:1)	IEA1 (def:1)	IEA0 (def:1)	IEZ7 (def:1)	IEZ6 (def:1)	IEZ5 (def:1)	IEZ4 (def:1)	IEZ3 (def:1				CRC
Comparator Operation Control Command	CMR	0x42			CMB5 (def:1)	CMB4		CMB2	CMB1				CMA5	CMA4 (def:1)	CMA3	CMA2	CMA1 (def:1)	CMA0	CMZ7 (def:1)	CMZ6	CMZ5	CMZ4	CMZ3	CMZ2 (def:1)	CMZ1	CMZ0	CRC
[Default: Valid] Comparator Threshold Selection Command	CTR	0x43	CTB	CTA	CTZ	(def:1)	(def:1)	(der:1)	(der:1)	(der:1)	(der:1)	(def:1)	(def:1)	(def:1)	(der:1)	(def:1)	(der:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(der:1	(def:1)	(def:1)	(def:1)	CRC
[Default: 3.0V] INZ Current Source/Sink Selection Command	PUDR	0x44	(def:0)	(def:0)	(def:0)														PUD7	PUD6	PUD5	PUD4	PUD3	PUD2	PUD1	PUD0	CRC
[Default: Source] Current Source Activation Command	-	-	CEB	CEA	CEZ														(def:0)	(def:0)	(def:0)	(def:0)	(def:0	(def:0)	(def:0)	(def:0)	
[Default: OFF (Invalid)] Holding Current / Wetting Current Level Selection	CER	0x45	(def:0)	(def:0)	(def:0)																						CRC
Command (LSB)	LCR	0x46	CRH1 (def:0)	CRH0 (def:0)	LCB5 (def:1)	LCB4 (def:1)	LCB3 (def:1)	LCB2 (def:1)	LCB1 (def:1)	LCB0 (def:1)	LCA7 (def:1)	LCA6 (def:1)	LCA5 (def:1)	LCA4 (def:1)	LCA3 (def:1)	LCA2 (def:1)	LCA1 (def:1)	LCA0 (def:1)		LCZ6 (def:1)	LCZ5 (def:1)	LCZ4 (def:1)	LCZ3 (def:1		LCZ1 (def:1)		CRC
[Default: Wetting current =1mA (Holding current)] Holding Current / Wetting Current Level Selection			(******	(MCB5	MCB4	мсвз	MCB2	MCB1	мсво	MCA7	MCA6	MCA5		MCA3	MCA2	MCA1	MCA0		MCZ6	MCZ5	MCZ4	· ·	. ,	· ,	· ·	
Command (MSB) [Default: Wetting current =1mA (Holding current)]	MCR	0x47			(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)		(def:0)	(def:0)	(def:0)					CRC
Wetting Current Operation Control Command	WTR	0x48			WTB5 (def:0)	WTB4 (def:0)	WTB3 (def:0)	WTB2 (def:0)	WTB1 (def:0)	WTB0 (def:0)	WTA7 (def:0)	WTA6 (def:0)	WTA5	WTA4 (def:0)	WTA3 (def:0)	WTA2 (def:0)	WTA1 (def:0)	WTA0 (def:0)		WTZ6 (def:0)	WTZ5 (def:0)	WTZ4 (def:0)				WTZ0 (def:0)	CRC
[Default: Invalid] n-Times Matched Filter Activation Control Command	DFR	0x49	DFB2	DFB1	DFB0	DFA2	DFA1	DFA0	DFZ2	DFZ1	DFZ0	(der.u)	(der.u)	(der:0)	(der:0)	(der.0)	(der.u)	(der.u)	(der.0)	(der:0)	(der.u)	(der:0)	(der.u	(der.u)	(der.u)	(der.u)	CRC
[Default: Invalid] DMUX Setting Command	DMR	0x4A	(def:0) DMX4	(def:0) DMX3	(def:0) DMX2	(def:0) DMX1	(def:0) DMX0	(def:0)	(def:0)	(def:0)	(def:0)					-											CRC
[Default: Invalid] Normal Mode Setting Command	Diwity	0,47	(def:0) FSQ	(def:0) FSQB	(def:0) FSQA	(def:0) FSQZ	(def:0) FITB2		FITB0	FITA2	FITA1	FITA0	FITZ2	FITZ1	FITZ0	SVW1	SVW0	FITB3	FITA3	FITZ3							ONO
[Default: Full-time monitor,Strobe time:125us, Sequential	FMR	0x4B	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	FITB1 (def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:1)	(def:0)		(def:0)							CRC
monitor is invalid] Sleep Mode Setting Command	SMR	0x4C	SSQ	SSQB	SSQA	SSQZ	SITB2	SITB1	SITB0	SITA2	SITA1	SITA0	SITZ2	SITZ1	SITZ0			SITB3	SITA3	SITZ3							CRC
[Default: Monitor period:50ms,Sequential monitor is invalid] Detection Edge Selection Command	ISR	0x4D	(def:0) ISB	(def:0) ISA	(def:0) ISZ	(def:0)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)			(def:0)	(def:0)	(def:0)							CRC
[Default: Both edges] Automatic Mode Transition Command			(def:1) MR_	(def:1)	(def:1)																						
[Default: Automatic transition is valid]	MIR	0x4E	IER (def:1)																								CRC
Monitor Mode Ttransition Command [Default: Normal mode]	MDR	0x4F	MDC (def:0)																								CRC
Reset Command	RST	0x5F																									CRC
Interrupt Notification of Switch Change Setting Command Read	RIER	0x61																									CRC
Comparator Operation Control Command Read	RCMR	0x62																									CRC
Comparator Threshold Selection Command Read	RCTR	0x63																									CRC
INZ Current Source/Sink Selection Command Read	RPUDR	0x64																									CRC
Current Source Activation Command Read	RCER	0x65																									CRC
Holding Current / Wetting Current Level Selection Command (LSB) Read	RLCR	0x66																									CRC
Holding Current / Wetting Current Level Selection Command (MSB) Read	RMCR	0x67																									CRC
Wetting Current Operation Control Command Read	RWTR	0x68																									CRC
n-Times Matched Filter Activation Control Command Read	RDFR	0x69																									CRC
DMUX Setting Command Read	RDMR	0x6A																									CRC
Normal Mode Setting Command Read	RFMR	0x6B																									CRC
Sleep Mode Setting Command Read	RSMR	0x6C																									CRC
Detection Edge Selection Command Read	RISR	0x6D																									CRC
Automatic Mode Transition Command Read	RMIR	0x6E																									CRC
Monitor Mode Ttransition Command Read	RMDR	0x6F																									CRC
TEST Command [Default: Invalid]	TSR	0x79	TSS7 (def:0)	TSS6 (def:0)	TSS5 (def:0)	TSS4 (def:0)	TSS3 (def:0)	TSS2 (def:0)	TSS1 (def:0)	TSS0 (def:0)																	CRC

Register Name	Symbol	-											F	Read Da	ata Nam	e											CRC
		39:32	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7:0
Interrupt Notification of Switch Change Setting Command Read	RIER	"100", Interrupt Factor	0	0	IEB5 (def:1)					IEB0 (def:1)						IEA2 (def:1)			(def:1)		IEZ5 (def:1)	IEZ4 (def:1)	IEZ3 (def:1)	IEZ2 (def:1)			CRC
Comparator Operation Control Command Read	RCMR	"100", Interrupt Factor	0	0				CMB2 (def:1)		CMB0 (def:1)						CMA2 (def:1)						CMZ4 (def:1)		CMZ2 (def:1)			CRC
Comparator Threshold Selection Command Read	RCTR	"100", Interrupt Factor	CTB (def:0)	CTA (def:0)	CTZ (def:0)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CRC
NZ Current Source/Sink Selection Command Read	RPUDR	"100", Interrupt Factor	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0						PUD2 (def:0)			CRC
Wetting Current Operation Control Command Read	RCER	"100", Interrupt Factor				0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CRC
Holding Current / Wetting Current Level Selection Command (LSB) Read	RLCR	Interrupt Factor				(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)		(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)		(def:1)	CRC
Holding Current / Wetting Current Level Selection Command (MSB) Read	RMCR	"100", Interrupt Factor	0	0				MCB2 (def:0)	MCB1 (def:0)	MCB0 (def:0)						MCA2 (def:0)								MCZ2 (def:0)			CRC
Wetting Current Operation Control Command Read	RWTR	"100", Interrupt Factor	0	0	(def:0)	(def:0)	(def:0)	(def:0)	WTB1 (def:0)							WTA2 (def:0)								WTZ2 (def:0)			CRC
n-Times Matched Filter Activation Control Command Read	RDFR	"100", Interrupt Factor							DFZ2 (def:0)		DFZ0 (def:0)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CRC
DMUX Setting Command Read	RDMR	"100", Interrupt Factor	DMX4 (def:0)		DMX2 (def:0)			0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CRC
Normal Mode Setting Command Read	RFMR	"100", Interrupt Factor	FSQ (def:0)	FSQB (def:0)	FSQA (def:0)		FITB2 (def:0)		FITB0 (def:0)		FITA1 (def:0)					SVW1 (def:0)				FITZ3 (def:0)	0	0	0	0	0	0	CRC
Sleep Mode Setting Command Read	RSMR	"100", Interrupt Factor	SSQ (def:0)						SITB0 (def:1)					SITZ1 (def:1)	SITZ0 (def:1)	0	0	SITB3 (def:0)		SITZ3 (def:0)	0	0	0	0	0	0	CRC
Detection Edge Selection Command Read	RISR	"100", Interrupt Factor	ISB (def:1)	ISA (def:1)	ISZ (def:1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CRC
Automatic Mode Transition Command Read	RMIR	"100", Interrupt Factor	MR_ IER (def:1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CRC
Monitor Mode Ttransition Command Read	RMDR	"100", Interrupt Factor	MDC (def:0)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CRC

Table 37. Register Map (SO Bit Alignment)

Typical Performance Curves

Unless otherwise specified, VPUA=VPUB=13V, VDDI=5V, LVDD=AVDD=REF5 Series products (BD3375MUV-M/BD3375KV-C) use the same data.

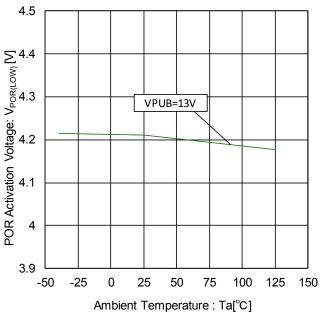


Figure 21. POR (Power on Reset) Activation Voltage - Temperature Characteristic

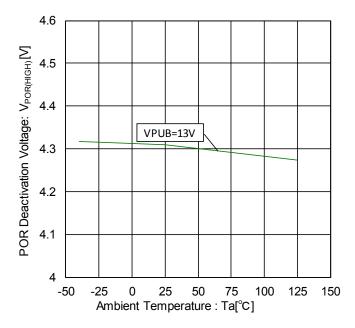
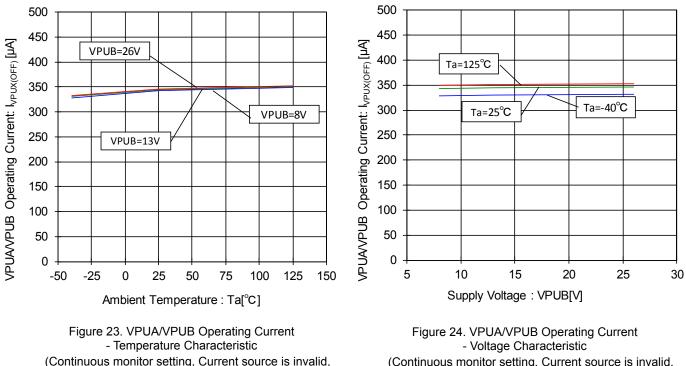
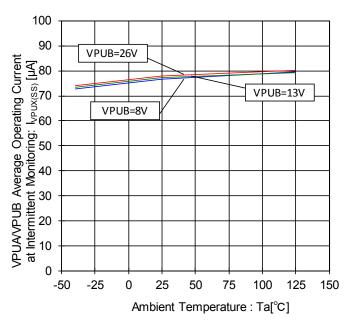


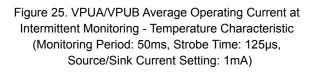
Figure 22. POR (Power on Reset) Deactivation Voltage -Temperature Characteristic

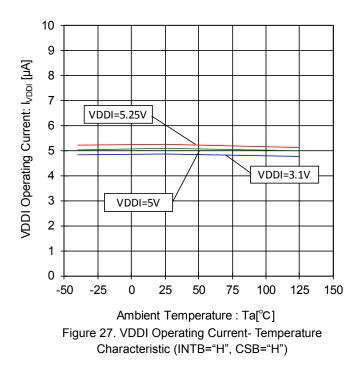


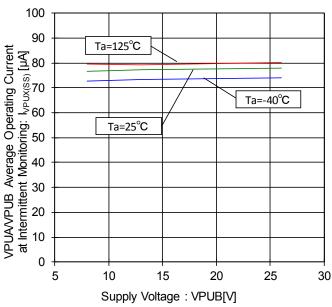
"Hi-Z" Status)

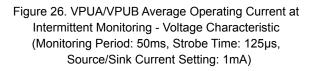
(Continuous monitor setting, Current source is invalid, "Hi-Z" Status)

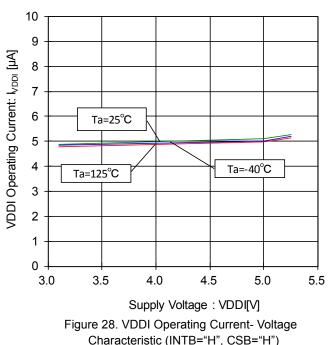


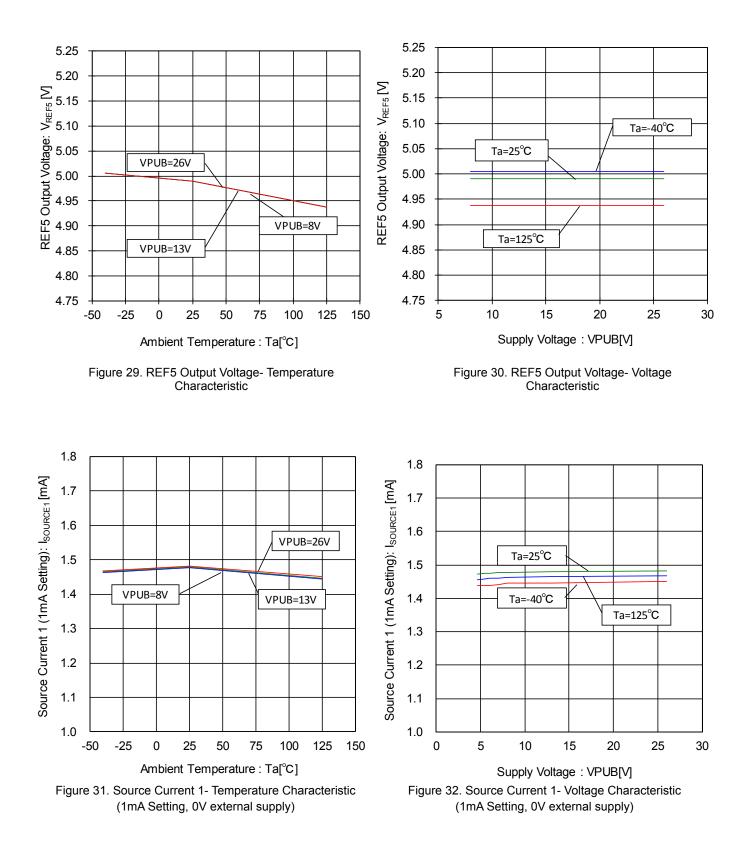


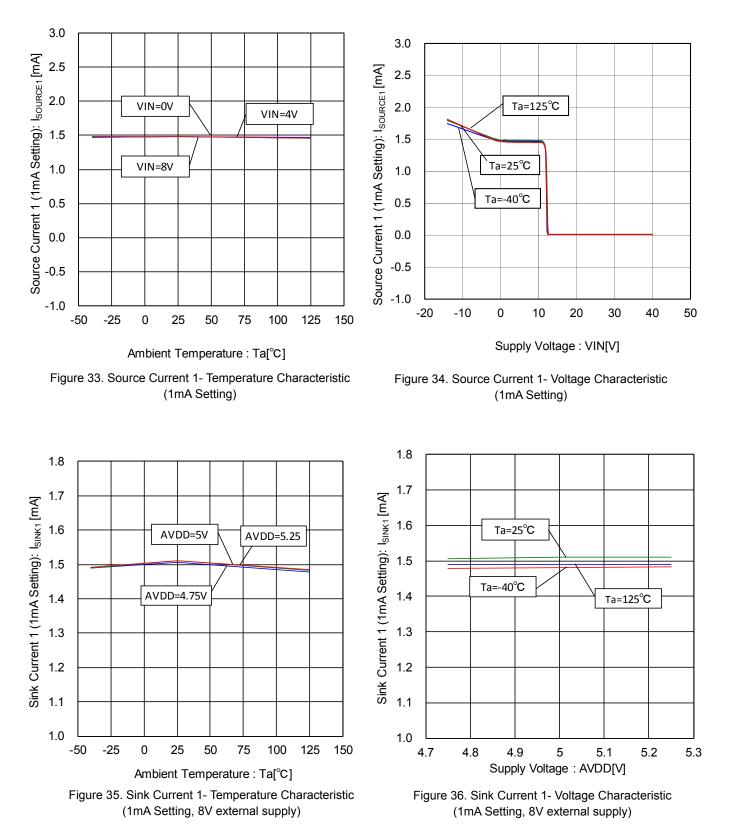


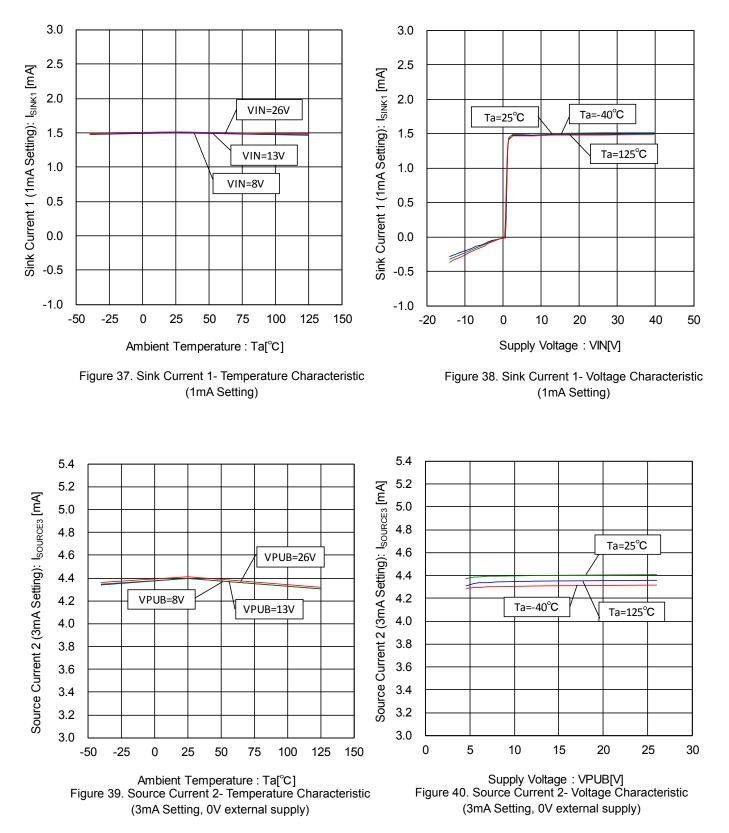


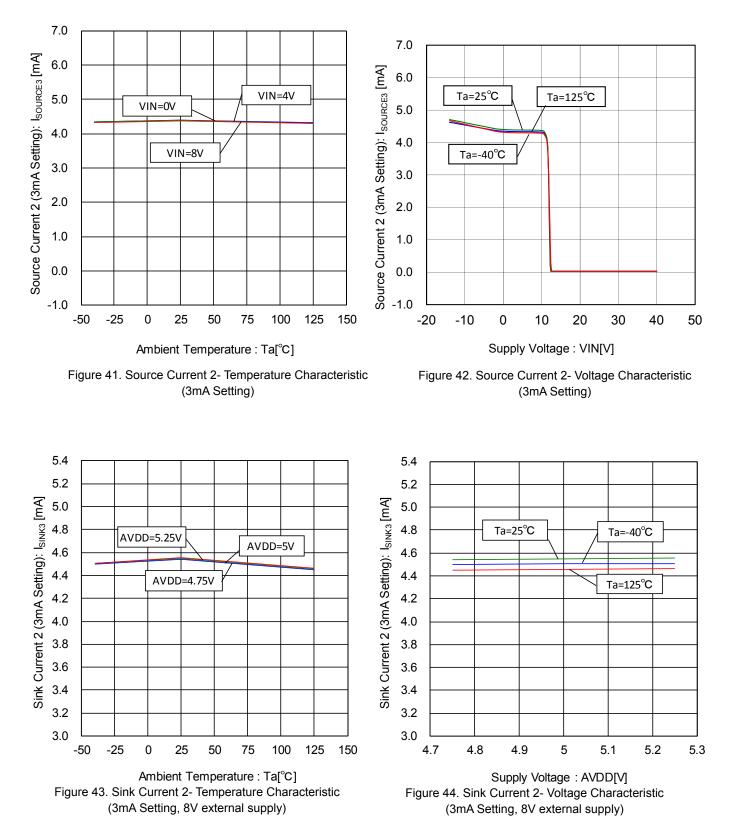


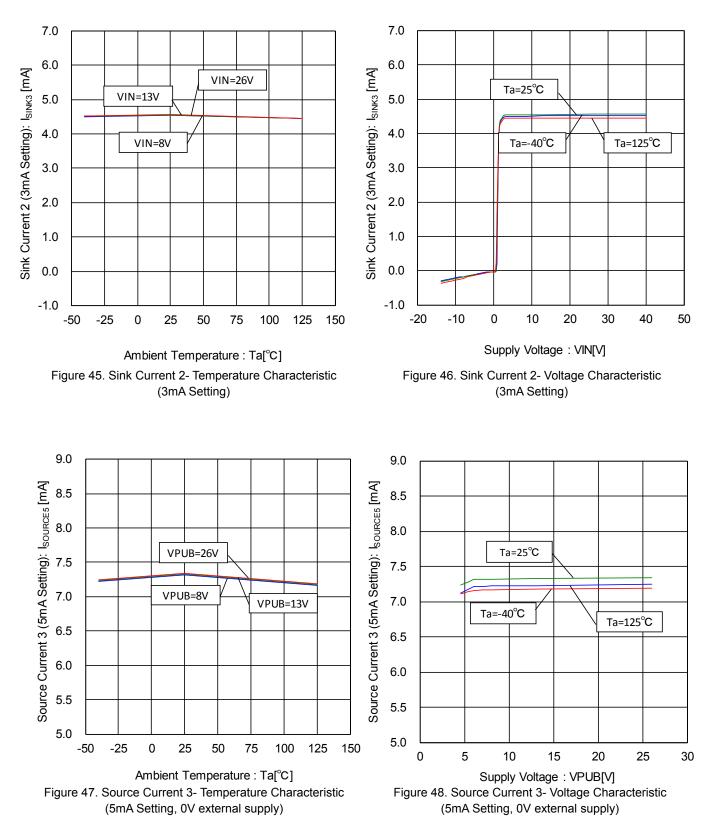


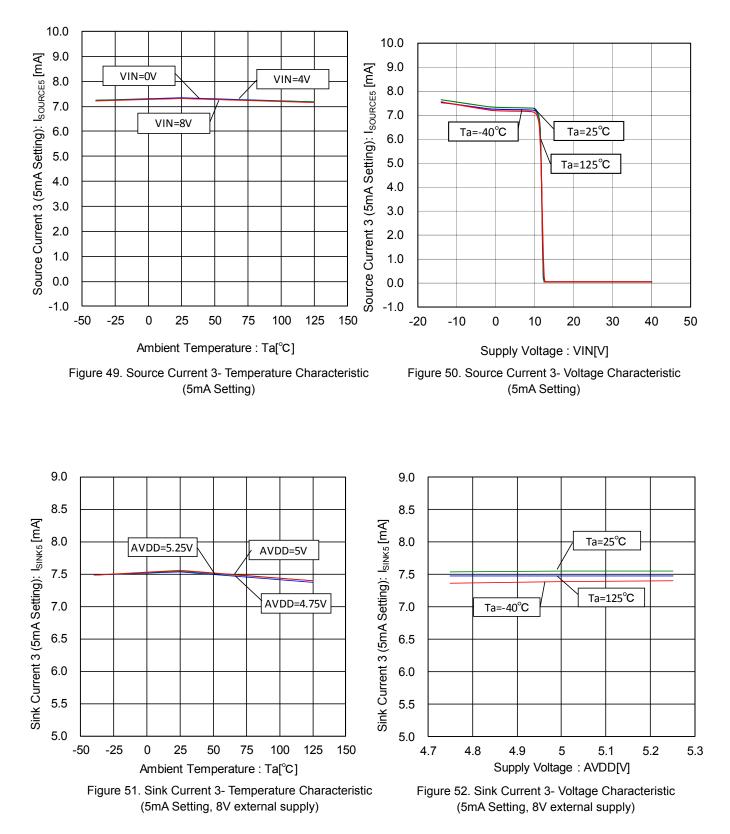


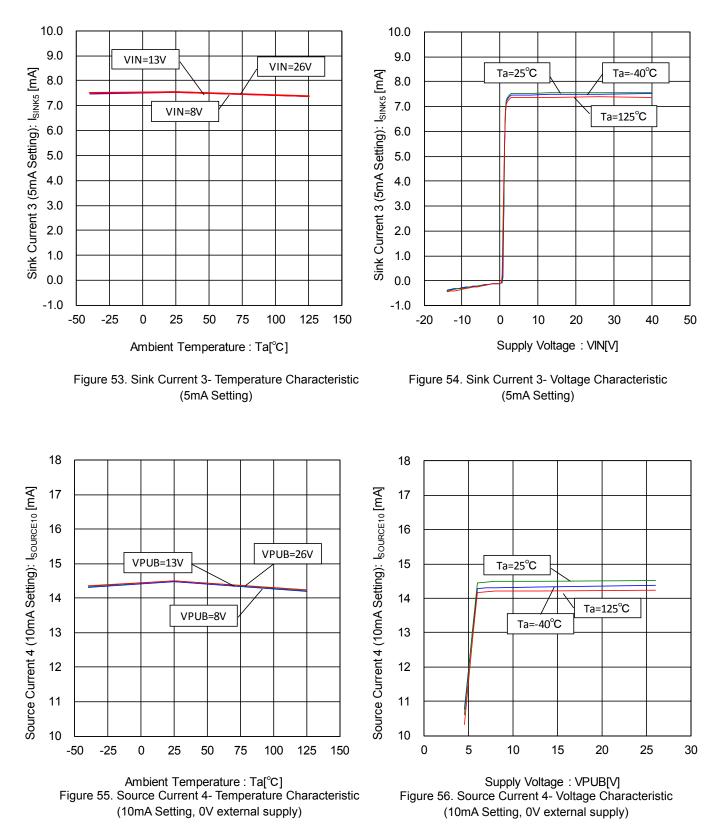


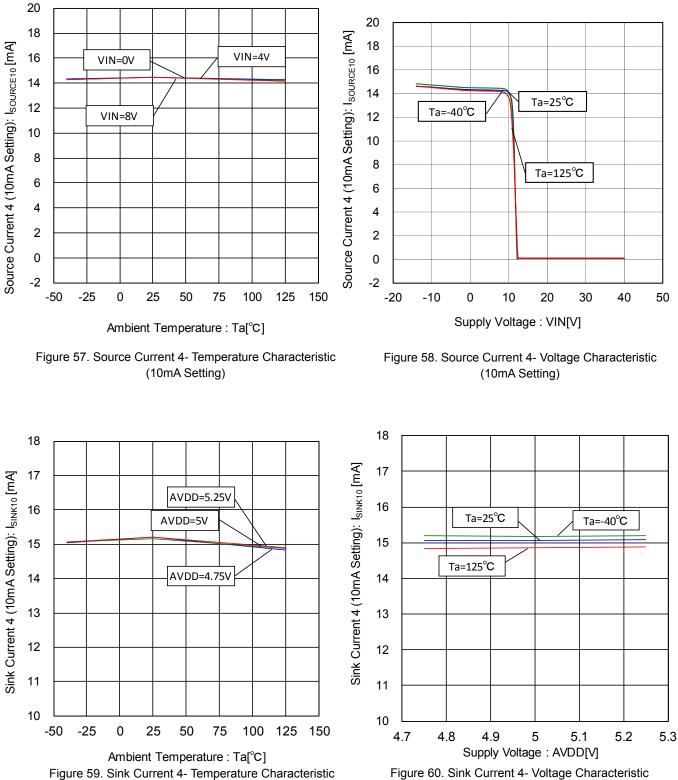






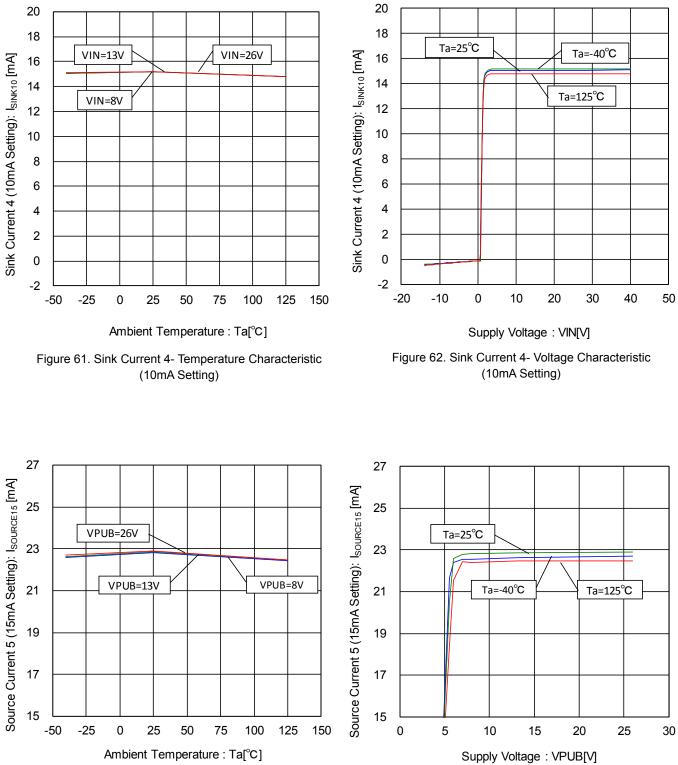






(10mA Setting, 8V external supply)

jure 60. Sink Current 4- Voltage Characteristic (10mA Setting, 8V external supply)



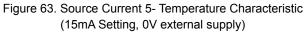


Figure 64. Source Current 5- Voltage Characteristic (15mA Setting, 0V external supply)

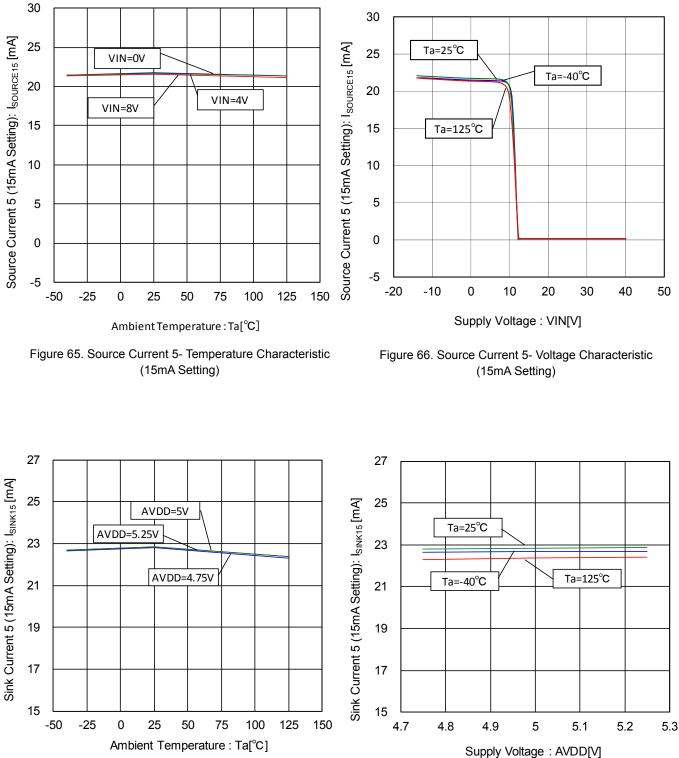
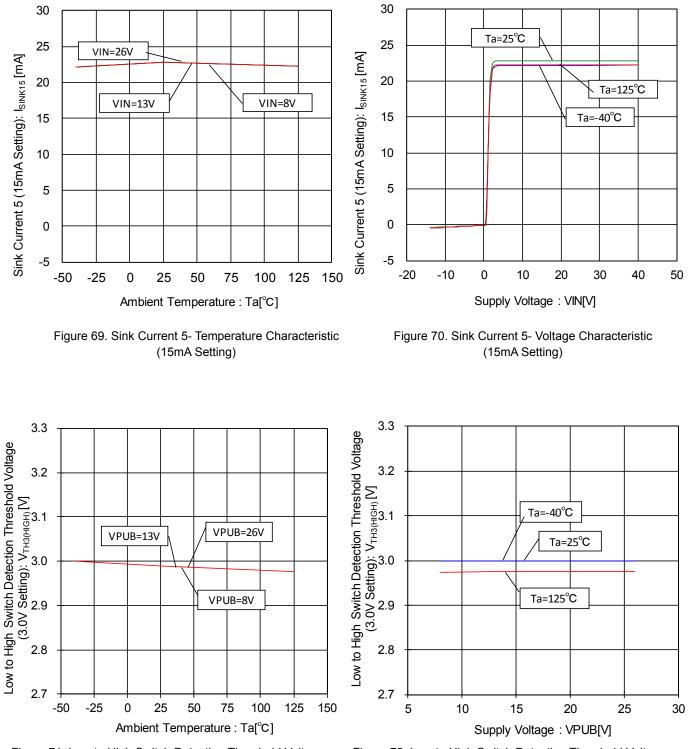


Figure 67. Sink Current 5- Temperature Characteristic (15mA Setting, 8V external supply)

Figure 68. Sink Current 5- Voltage Characteristic (15mA Setting, 8V external supply)



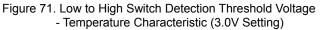


Figure 72. Low to High Switch Detection Threshold Voltage - Voltage Characteristic (3.0V Setting)

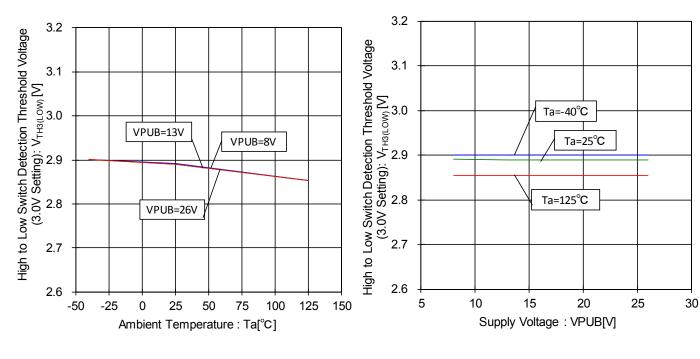
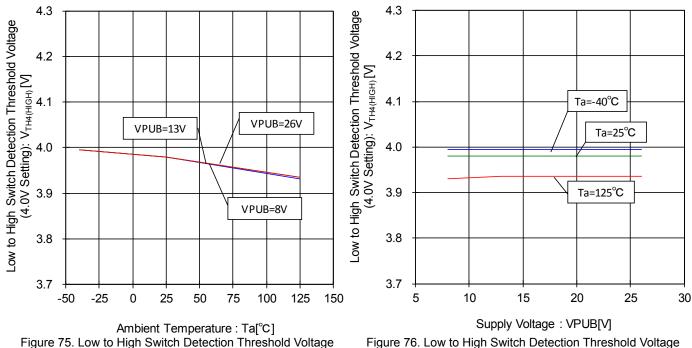


Figure 73. High to Low Switch Detection Threshold Voltage - Temperature Characteristic (3.0V Setting)





⁻ Temperature Characteristic (4.0V Setting)



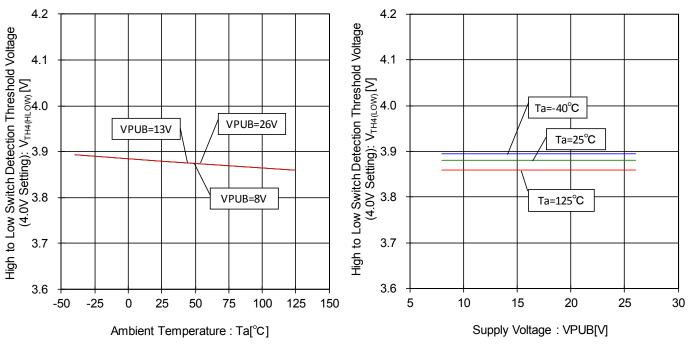
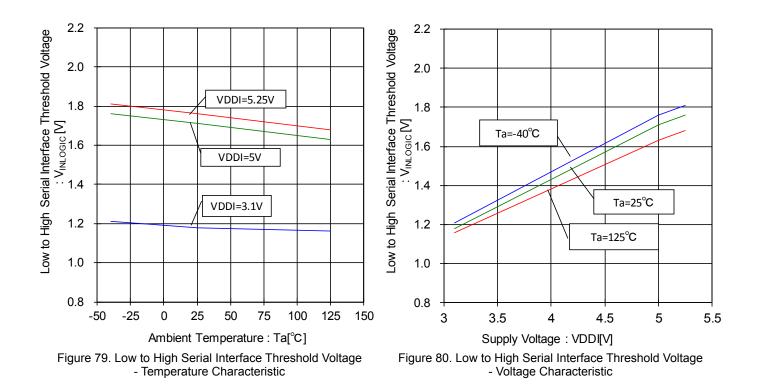
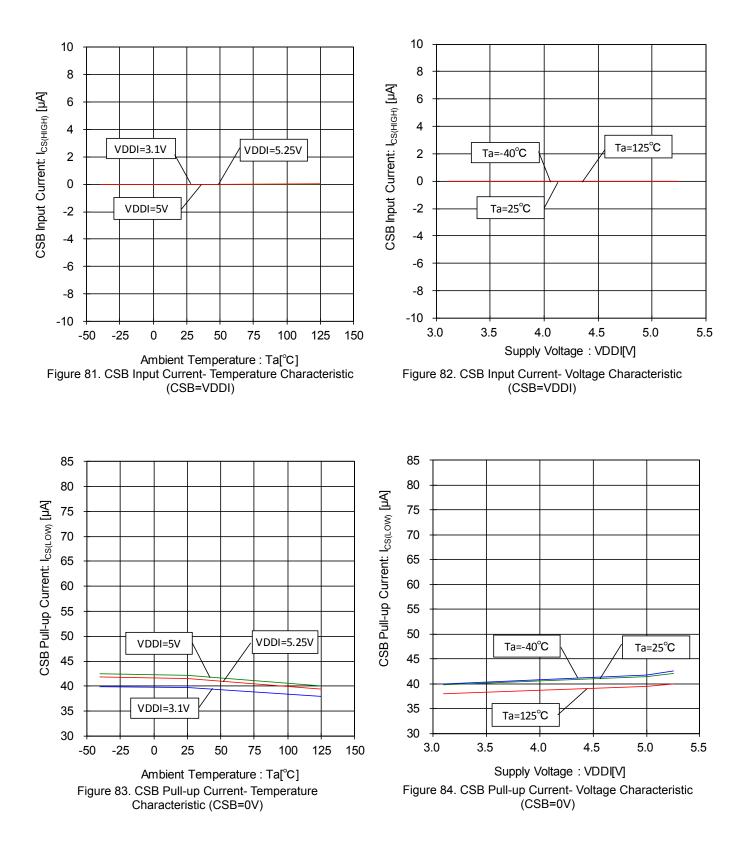
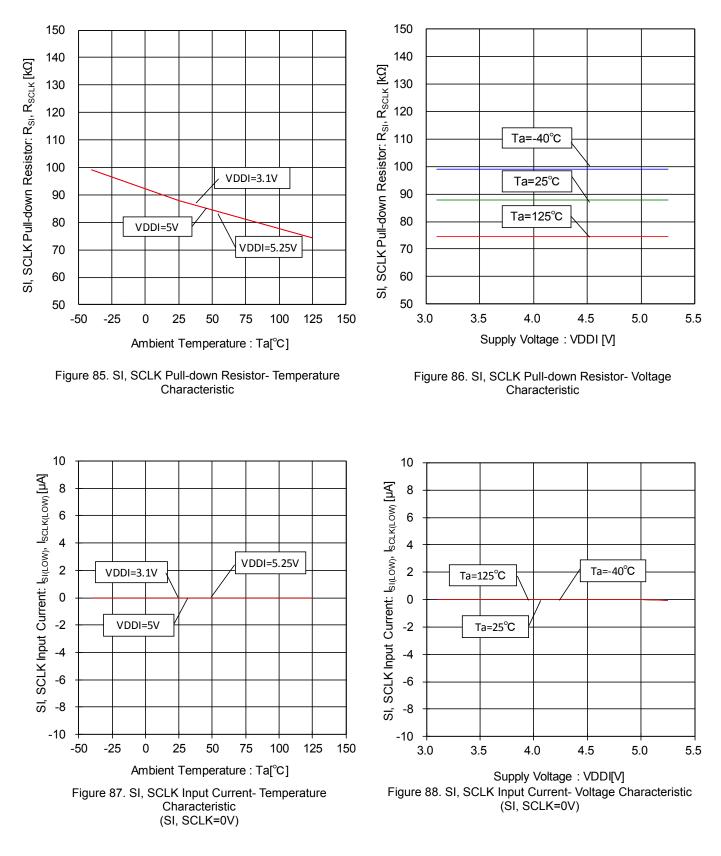


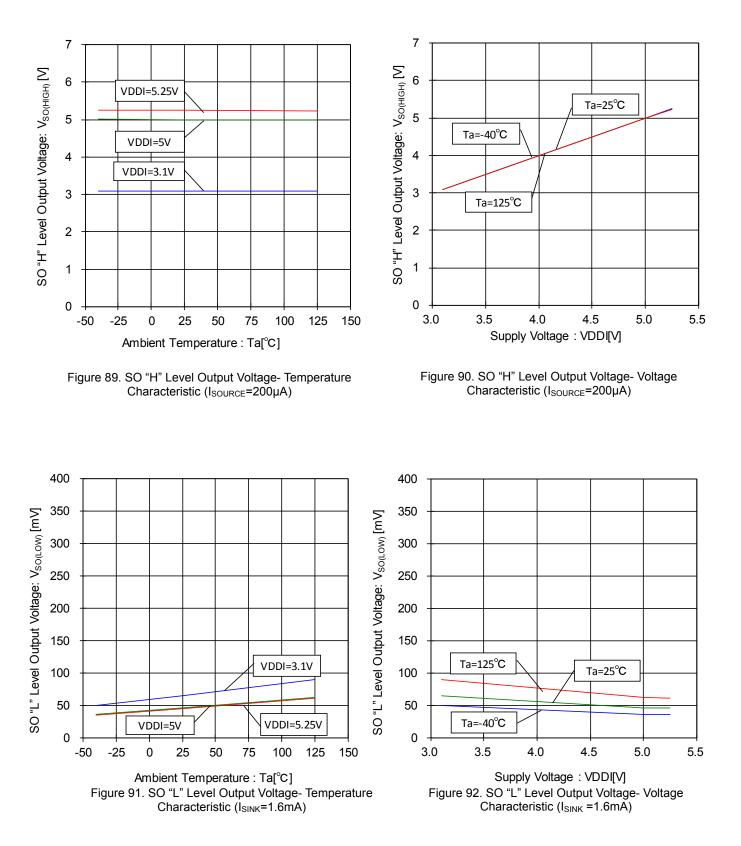
Figure 77. High to Low Switch Detection Threshold Voltage - Temperature Characteristic (4.0V Setting)

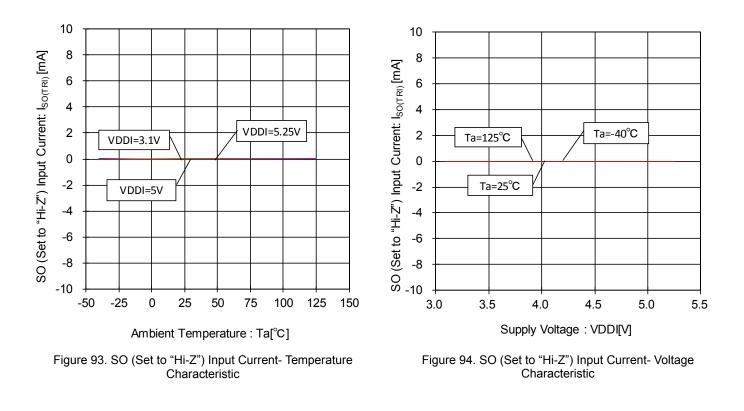












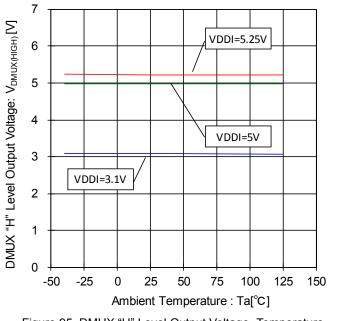
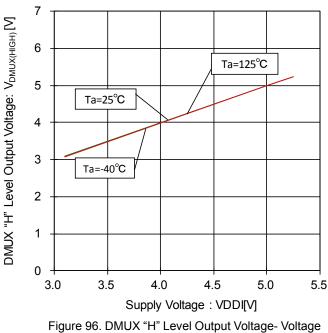


Figure 95. DMUX "H" Level Output Voltage- Temperature Characteristic (I_{SOURCE}=200µA)



Characteristic (I_{SOURCE}=200µA)

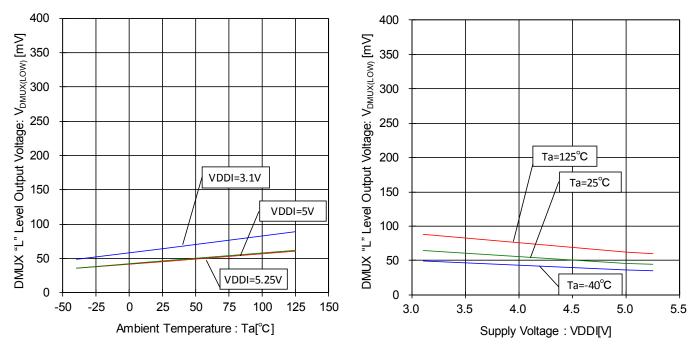
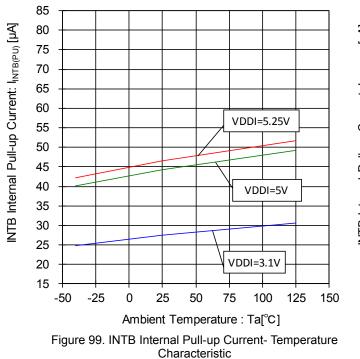
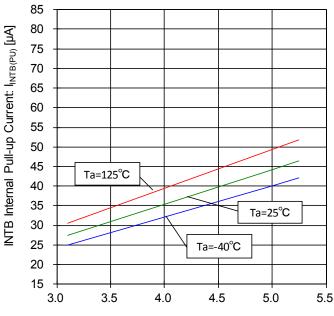


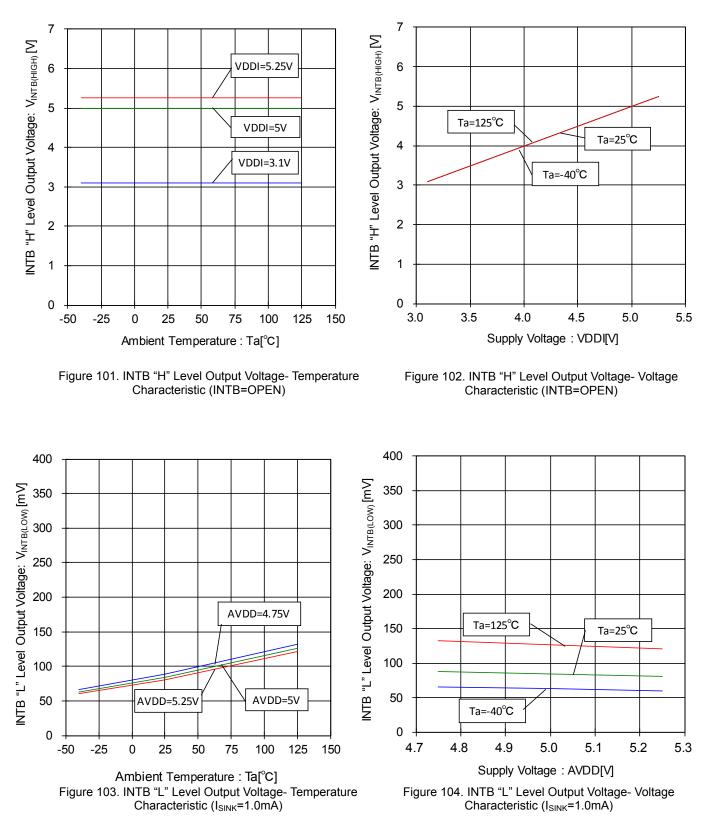
Figure 97. DMUX "L" Level Output Voltage- Temperature Characteristic (I_{SINK} =1.6mA)

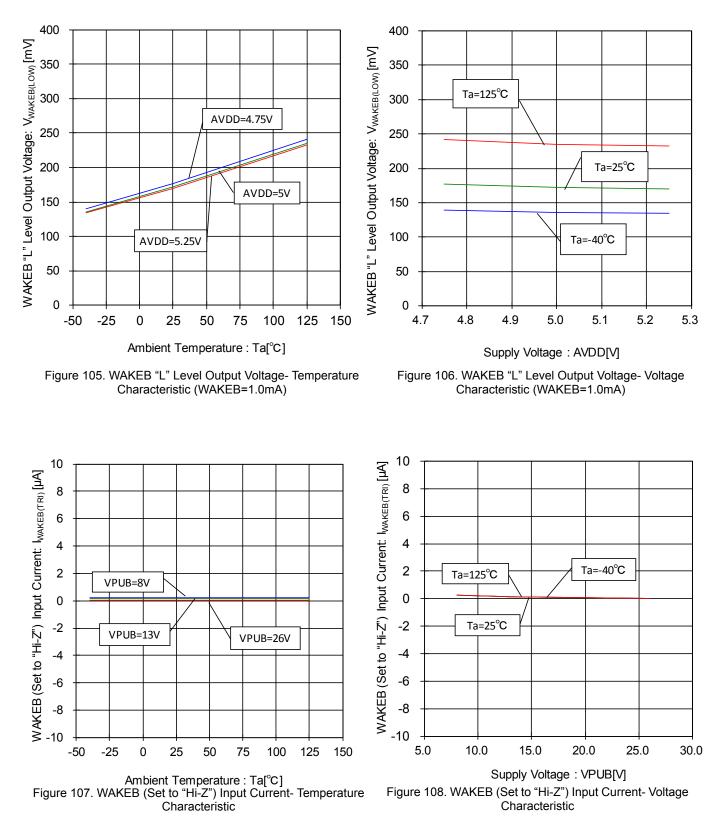
Figure 98. DMUX "L" Level Output Voltage- Voltage Characteristic (I_{SINK}=1.6mA)





Supply Voltage : VDDI[V] Figure 100. INTB Internal Pull-up Current- Voltage Characteristic





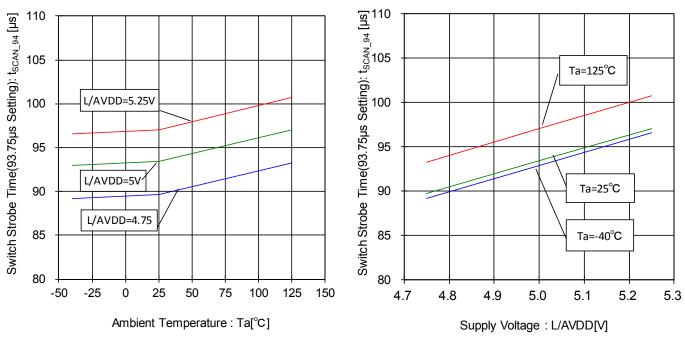
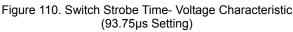
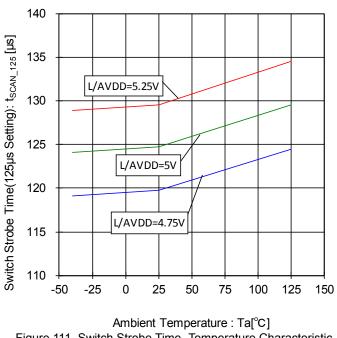
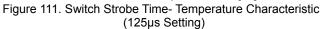


Figure 109. Switch Strobe Time- Temperature Characteristic (93.75µs Setting)







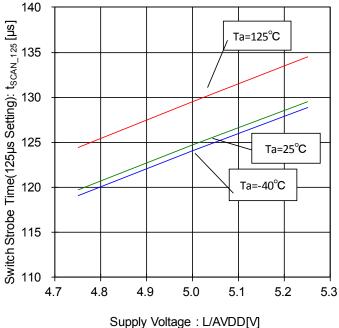
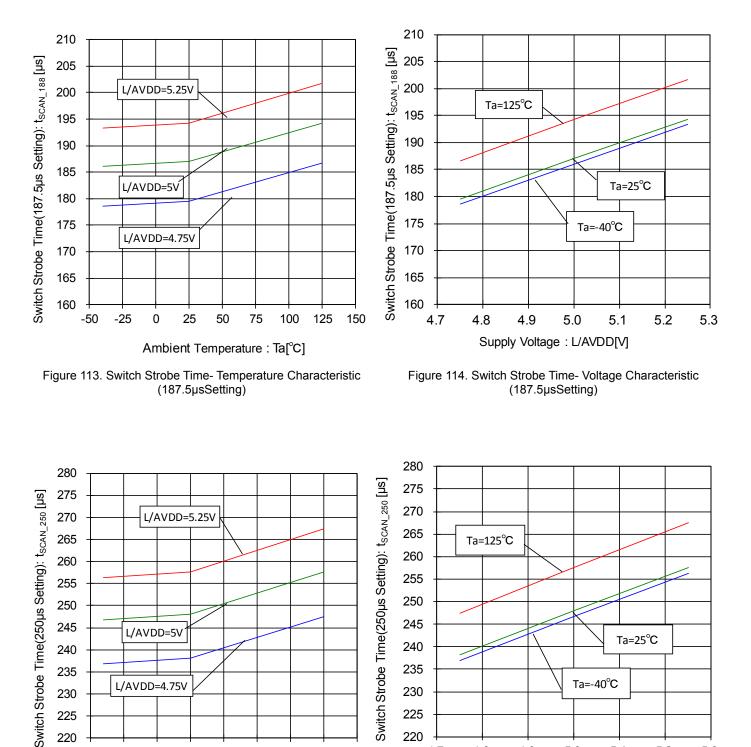


Figure 112. Switch Strobe Time- Voltage Characteristic (125µs Setting)



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L/AVDD=4.75V

0

25

50

Ambient Temperature : Ta[°C]

Figure 115. Switch Strobe Time- Temperature Characteristic

(250µs Setting)

75

100

125

150

-25

230

225

220

-50

Ta=-40°C

5.1

5.2

5.3

5.0

Supply Voltage : L/AVDD[V]

230

225

220

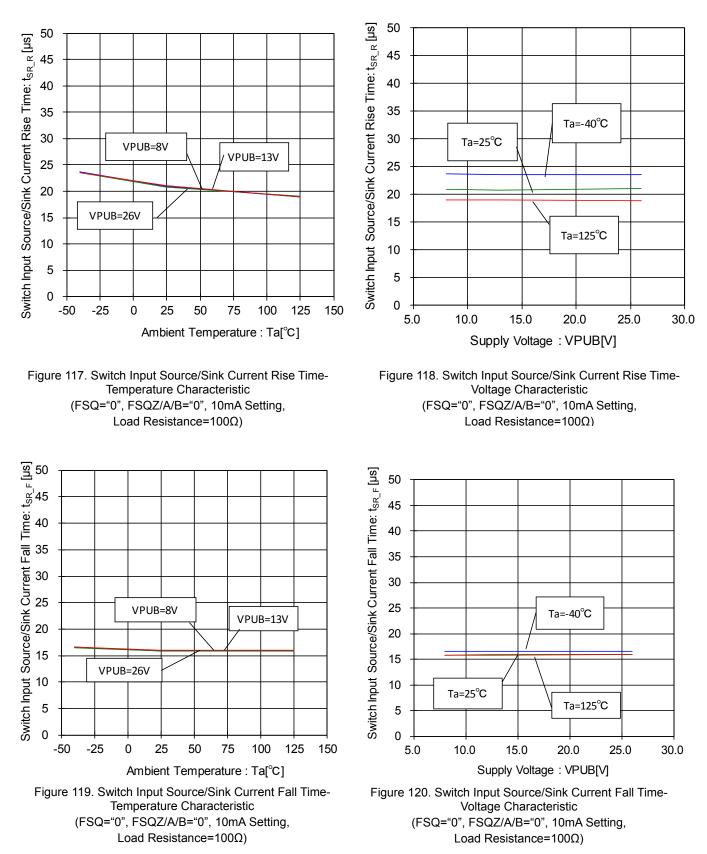
4.7

4.8

4.9

Figure 116. Switch Strobe Time- Voltage Characteristic

(250µs Setting)



Application Circuit Examples

1. Example of Application Circuit and its External Components

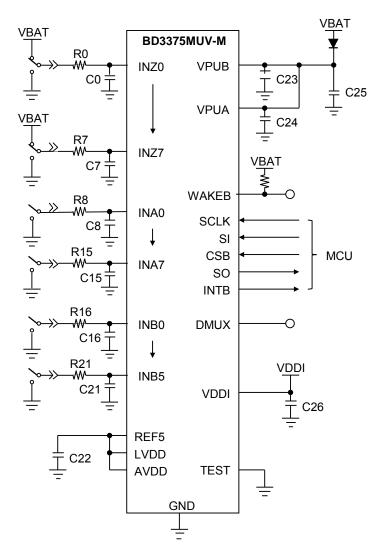


Figure 121. Example of Application Circuit and its External Components

- Capacitor (C23, C24, C26) at Power Supply Pins (VPUA, VPUB, VDDI) Insert a 0.1µF capacitor between each power supply pin (VPUA, VPUB, and VDDI) and ground. Make sure to design the external components with sufficient margin for the intended application. It is recommended to use capacitors with excellent voltage and temperature characteristics.
- Capacitor (C22) at REF5

In order to prevent oscillation, a capacitor needs to be placed between the REF5 output pin and ground. It is recommended to use a capacitor (electrolytic, tantalum, or ceramic of at least 4.7µF). Make sure that capacitance of 4.7µF or higher is maintained at the intended operating supply voltage and temperature range. Temperature change can cause fluctuation in capacitance, which may lead to oscillation. If a ceramic capacitor is chosen, it is recommended to use X5R, X7R, or any others with better temperature and DC biasing characteristics and higher voltage tolerance.

· Capacitor(C0 to C21) at Switch Pin (INZ, INA, INB)

It is recommended to use at least 0.1µF capacitors as protection against ESD. Make sure to design the external circuit with sufficient margin for the intended application. Use capacitors with application specific voltage and temperature characteristics.

· Resistor (R0 to R21) at Switch Pin (INZ, INA, INB)

Choose the appropriate resistor to reduce EMI noise. Design the circuit so the pin voltage does not fall below the threshold voltage defined by ground float of [Load Resistance] x [Wetting Current] (when wetting current is set to source) or voltage drop (when wetting current is set to sink) may occur.

2. Example of Parallel Connection Circuit

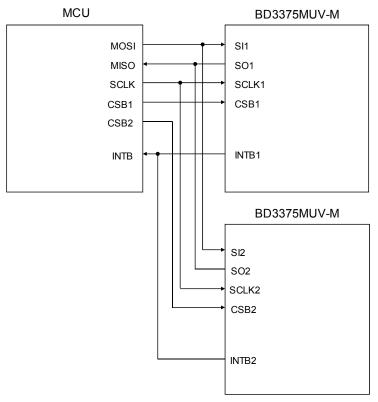
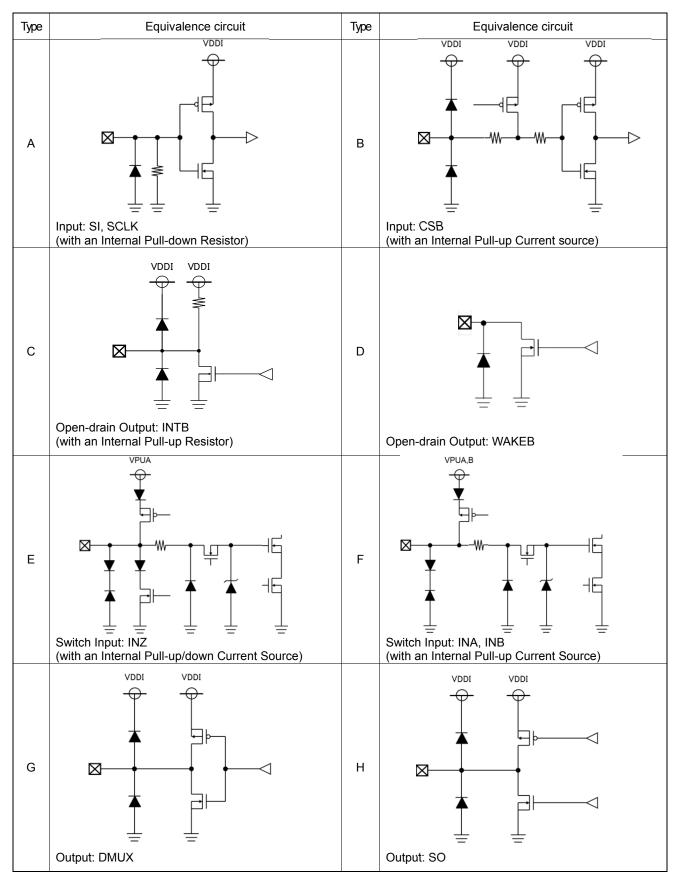


Figure 122. Example of Application Circuit and its External Components

Parallel Connection

Please prepare CSB terminals respectively.

I / O Equivalence Circuit



I / O Equivalence Circuit

Туре	Equivalence circuit	Туре	Equivalence circuit
1	VPUB VPUB	J	AVDD AVDD

Operational Notes

1. Reverse Connection of Power Supply

Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply pins.

2. Power Supply Lines

Design the PCB layout pattern to provide low impedance supply lines. Separate the ground and supply lines of the digital and analog blocks to prevent noise in the ground and supply lines of the digital block from affecting the analog block. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.

3. Ground Voltage

Except for pins the output and the input of which were designed to go below ground, ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition.

4. Ground Wiring Pattern

When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.

5. Thermal Consideration

Should by any chance the maximum junction temperature rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. In case of exceeding this absolute maximum rating, increase the board size and copper area to prevent exceeding the maximum junction temperature rating.

6. Recommended Operating Conditions

These conditions represent a range within which the expected characteristics of the IC can be approximately obtained. The electrical characteristics are guaranteed under the conditions of each parameter.

7. Inrush Current

When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.

8. Operation Under Strong Electromagnetic Field

Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.

9. Testing on Application Boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

10. Inter-pin Short and Mounting Errors

Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.

11. Unused Input Pins

Input pins of an IC are often connected to the gate of a MOS transistor. The gate has extremely high impedance and extremely low capacitance. If left unconnected, the electric field from the outside can easily charge it. The small charge acquired in this way is enough to produce a significant effect on the conduction through the transistor and cause unexpected operation of the IC. So unless otherwise specified, unused input pins should be connected to the power supply or ground line.

Operational Notes – continued

12. Regarding the Input Pin of the IC

This monolithic IC contains P+ isolation and P substrate layers between adjacent elements in order to keep them isolated. P-N junctions are formed at the intersection of the P layers with the N layers of other elements, creating a parasitic diode or transistor. For example (refer to figure below):

When GND > Pin A and GND > Pin B, the P-N junction operates as a parasitic diode. When GND > Pin B, the P-N junction operates as a parasitic transistor.

Parasitic diodes inevitably occur in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions that cause these diodes to operate, such as applying a voltage lower than the GND voltage to an input pin (and thus to the P substrate) should be avoided.

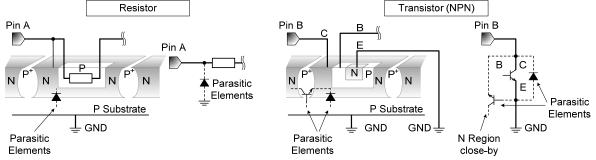


Figure 123. Example of monolithic IC structure

13. Ceramic Capacitor

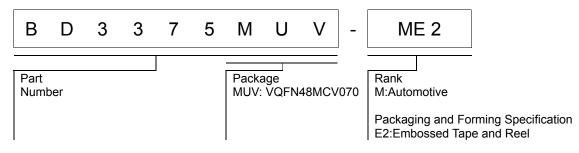
When using a ceramic capacitor, determine the dielectric constant considering the change of capacitance with temperature and the decrease in nominal capacitance due to DC bias and others.

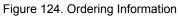
14. Thermal Shutdown Circuit(TSD)

This IC has a built-in thermal shutdown circuit that prevents heat damage to the IC. Normal operation should always be within the IC's maximum junction temperature rating. If however the rating is exceeded for a continued period, the junction temperature (Tj) will rise which will activate the TSD circuit that will turn OFF all output pins. When the Tj falls below the TSD threshold, the circuits are automatically restored to normal operation.

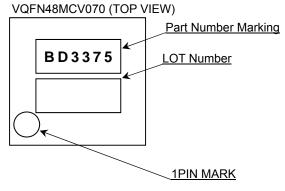
Note that the TSD circuit operates in a situation that exceeds the absolute maximum ratings and therefore, under no circumstances, should the TSD circuit be used in a set design or for any purpose other than protecting the IC from heat damage.

Ordering Information





Marking Diagrams (Top View)





Physical Dimensions, Tape and Reel information VQFN48MCV070 Package Name $7. 0 \pm 0. 1$ 0±0. 2 Ο 1 1 PIN MARK 0 2 +0. 03 <u>.</u> 22) OMAX <u>o</u> S 0. _____ п <u>ت</u>ہ 0. 08S (0.23) (0. 1) 5. 6 ± 0.1 C0. 3 12 L 3 48כ 6 ± 0 . ي. ي $4 \pm 0.$ ר 0. 37 24 \cap Π Г (UN I T : mm) 25 36 PKG:VQFN48MCV070 Drawing No.EX389-5001 0.75 0.25±0.08 0.5 < Tape and Reel Information > Tape Embossed carrier tape with dry pack 1500pcs Quantity Direction of feed E2 The direction is the pin 1 of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand 0 0 0 0 0 0 0 0 0 0 0 0 123 123 1234 123 1232 23 Direction of feed Pin 1 Reel

Figure 126. Physical Dimensions, Tape and Reel information

Revision History

Date	Rev.	History
29.Jan.2016	001	(Japanese Only)
27.Sep.2016	002	New Release
19.Jun.2017	003	 P3 Table 1 Modified Description of INTB. P3 Note 2 Modified Reference Page P8 Table 8 Modified Parameter of VDDI Operating Current. P11 Table 11 Added Note to Typ value of "Source/Sink Current Rise Time". P12 Table 12 Added Note to Typ value of "SI, CSB, SCLK Rise Time". P20,36 Changed Note No. P42-50 Figure 34,42,50,58,66 Modified Performance Curves. P67 Modified Equivalence Circuit of REF5.

Notice

Precaution on using ROHM Products

1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

JAPAN	USA	EU	CHINA				
CLASSI	CLASSⅢ	CLASS II b					
CLASSⅣ	CLASSI	CLASSII	CLASSⅢ				

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:

[a] Installation of protection circuits or other protective devices to improve system safety

[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

- 3. Our Products are not designed under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

Precaution Regarding Intellectual Property Rights

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General Precaution

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